

Large Area Picosecond Microchannel Plate Photodetectors

Bob Wagner
Argonne HEP Division
Wednesday 25 July 2012
for the LAPPD Collaboration

The Large Area Picosecond Photodetector Participants During the First 3 Years

▶ National Labs

- Argonne
 - HEP Division
 - Energy Systems Division
 - Nuclear Engineering Division
 - Glass Shop
 - X-ray Sciences Division
 - Materials Science Division
 - Mathematics and Computer Science Division
- Fermilab

▶ Universities

- University of Chicago
- Space Sciences Lab/UC–Berkeley
- University of Hawaii
- Washington University
- University of Illinois — Chicago
- University of Illinois — Urbana/Champaign

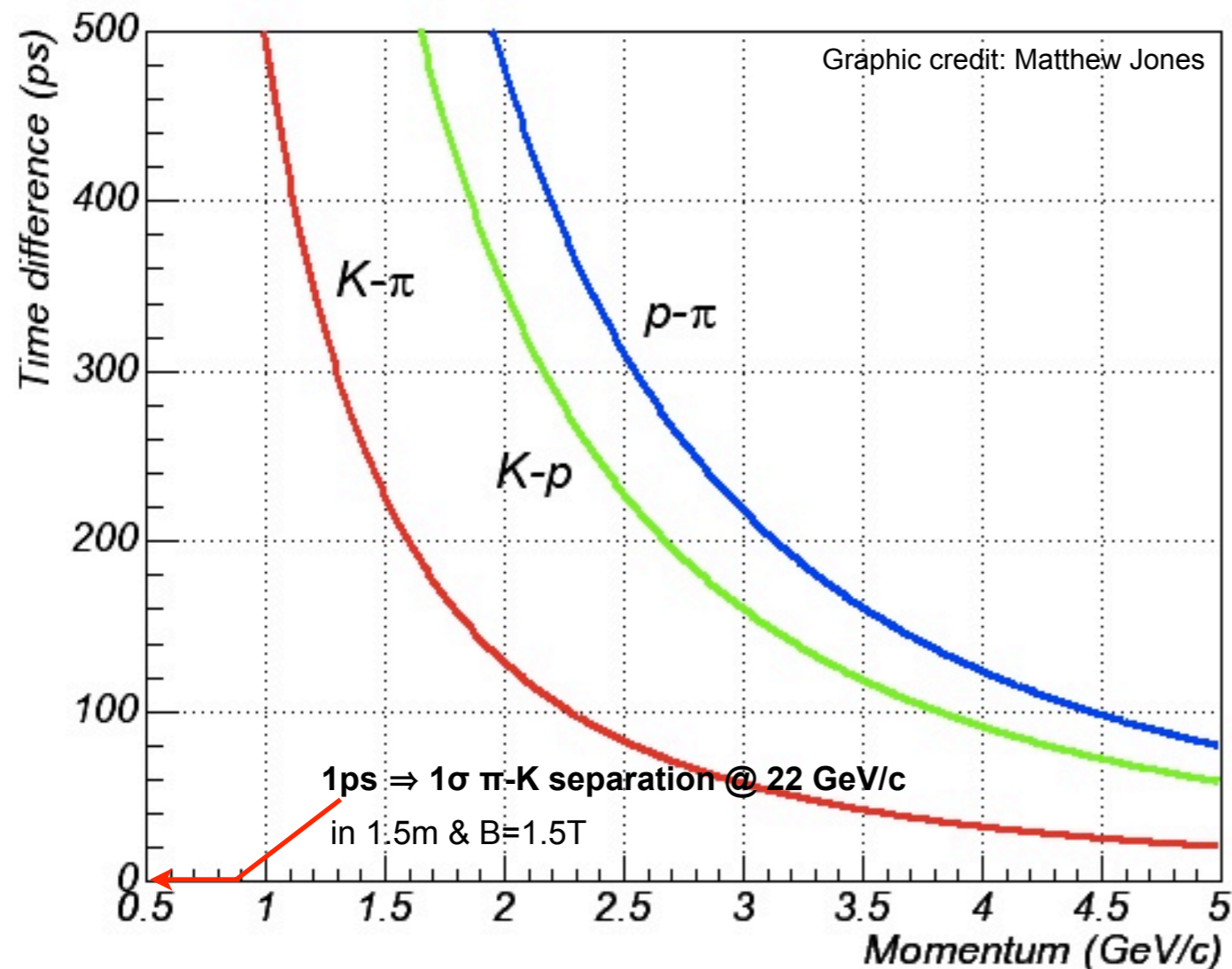
▶ U.S. Companies

- Incom, Inc.
- Arradance, Inc.
- Synkera Technologies, Inc.
- Minotech, Inc.
- Muons, Inc.

LAPPD is a multi-disciplinary/multi-institutional effort that draws on the unique expertise and infrastructure at Argonne and at our partner institutions

Motivation – Pushing the Limits of Time Resolution

- ▶ Project evolved from LDRD to improve Particle ID in colliding beam experiments



Goal is to measure ALL information allowing for identification of quarks producing the jets. Requires particle ID for momentum of 10's of GeV/c

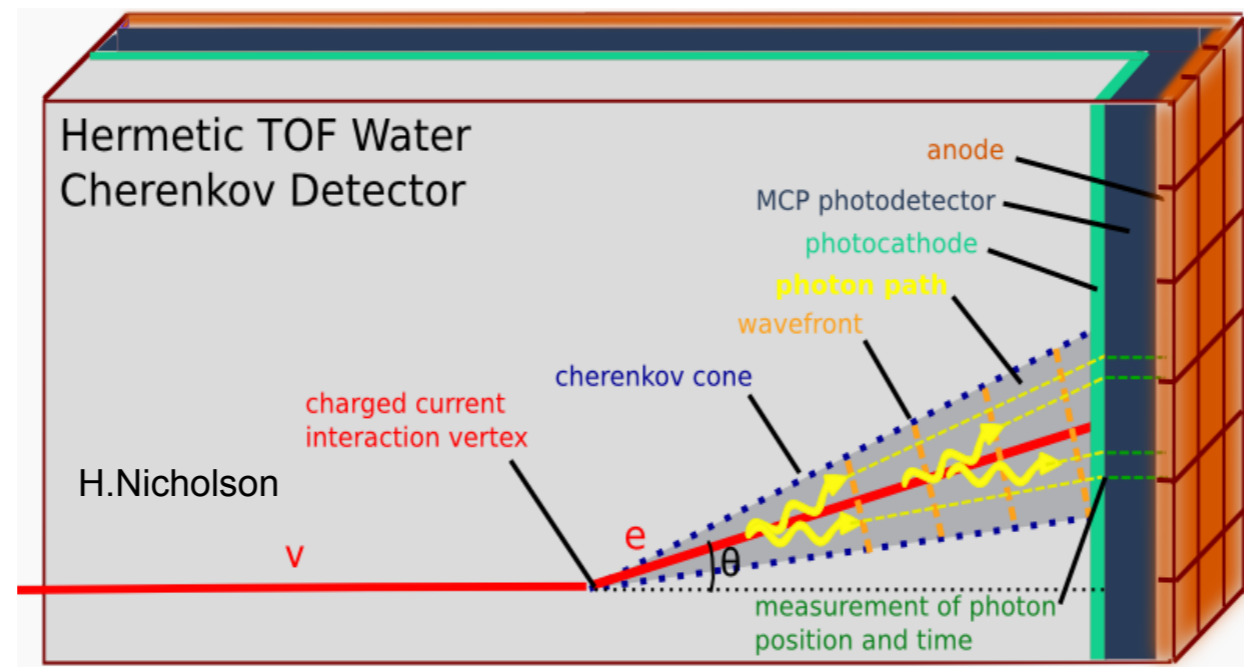
Several components contribute to time resolution limit:

- Signal source - absorption, scattering, thresholds
- Detector limits - efficiency, coverage, noise, dispersion
- Electronics - bandwidth, slewing, sampling speed, noise

Complete particle measurement: E, p + m(PID)
1ps time & 1mm space resolution

Applications – Tracking Neutrino Water Cherenkov Detector

Technique: measure arrival time and position of photons and reconstruct tracks in water

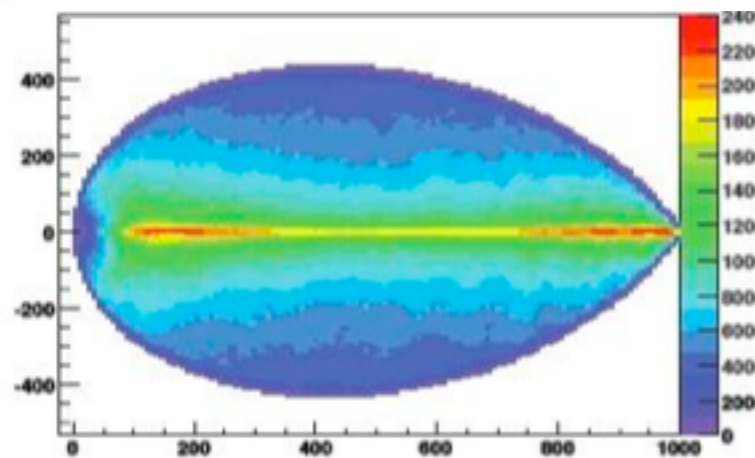


← Tessellation of detector with Large Area MCP-PMTs

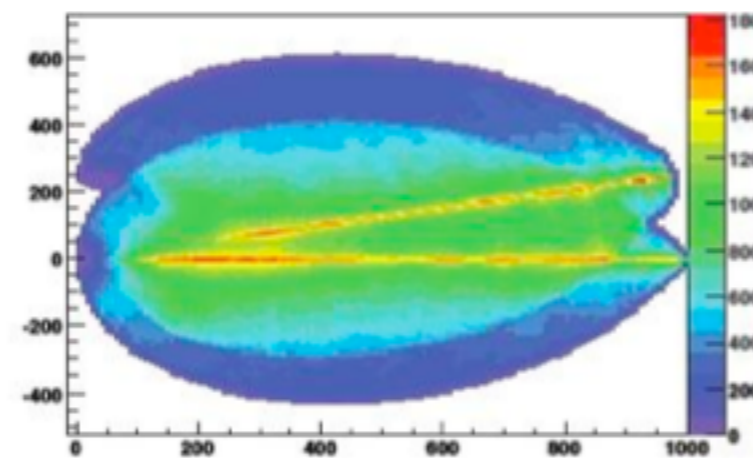
Results of a toy Monte Carlo with perfect resolution

Color scale shows the likelihood that light on the Cherenkov ring came from a particular point in space. Concentration of red and yellow pixels cluster around likely tracks

□



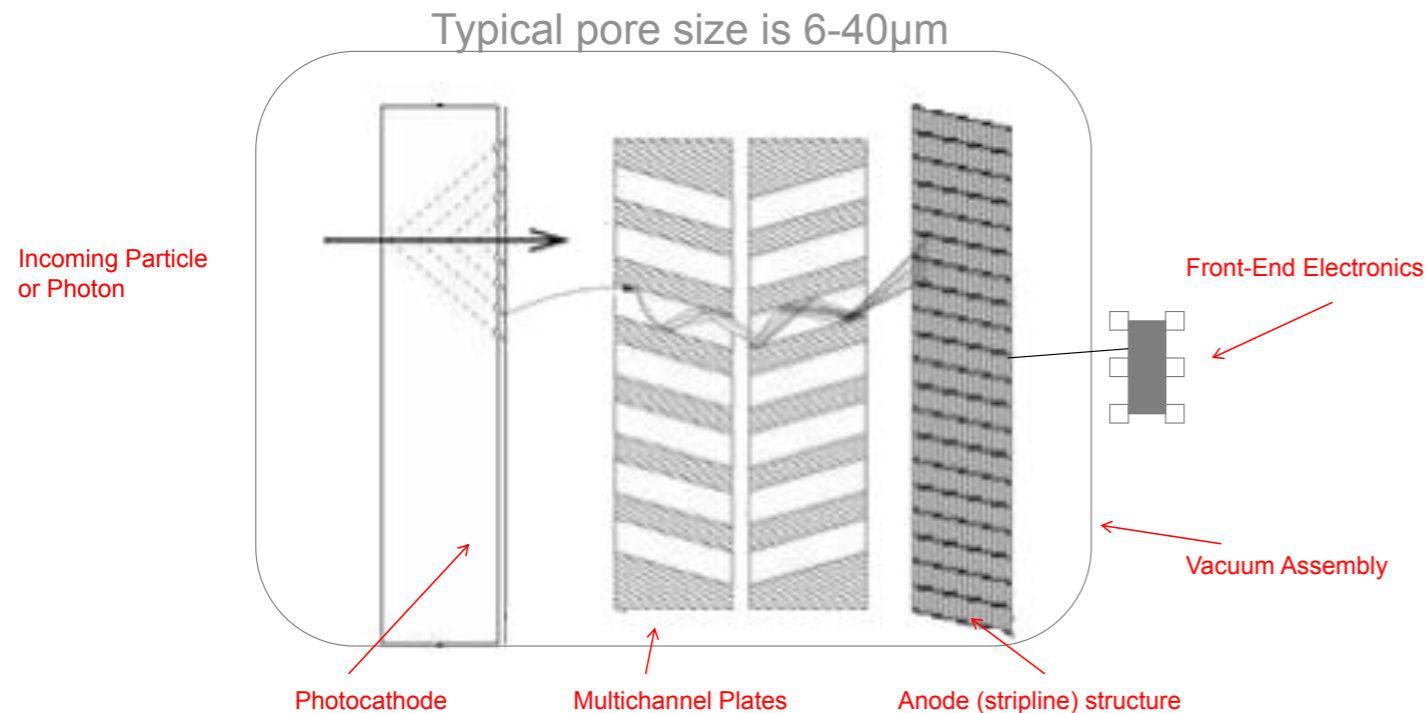
Single track



Two tracks displaced from a common vertex

graphic credit: Matt Wetstein

Microchannel Plate Photomultipliers



Existing commercial MCP-PMTs:

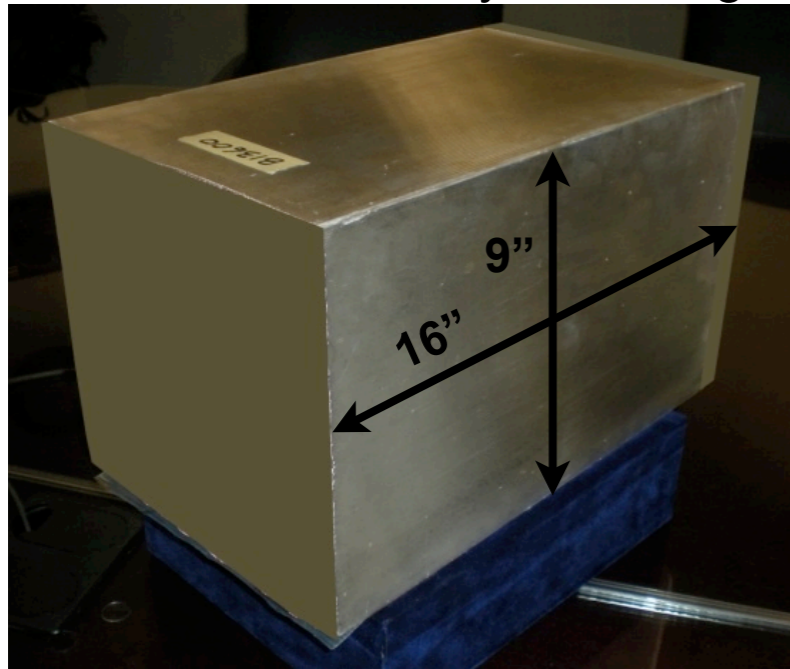
- ▶ MCP fabrication constrained by common material for substrate, resistive and emission layers
- ▶ $\leq \sim 25\text{mm}^2$ active area
- ▶ Expensive
- ▶ Can be difficult to obtain/purchase

Components of the Large Area Picosecond Photodetector Development:

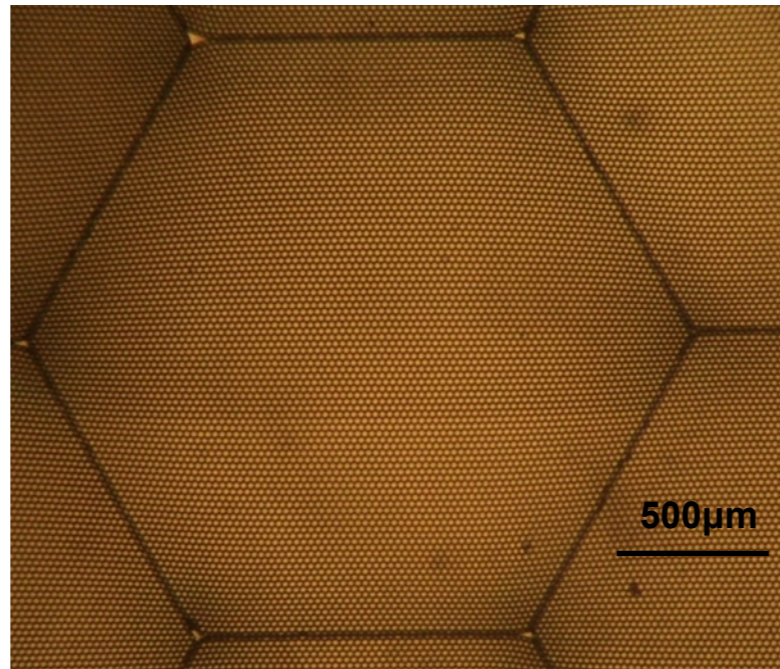
- ▶ Transformational improvement of MCP fabrication and size
 - ▶ 8" \times 8" borosilicate glass w/20&40 μm pore (33mm development disks)
 - ▶ Separate resistive & secondary emissive functions into 2 materials via ALD coating
- ▶ Development of planar, large-area photocathodes
- ▶ Waveform sampling 10GSa/s electronics readout for best time resolution
- ▶ Development of economical hermetic packaging
 - ▶ Standard ceramic package w/InBi hot seal & HV/signal pins feedthru — [SSL/UC-Berkeley](#)
 - ▶ Inexpensive borosilicate all-glass w/thermopressure seal, pinless — [Argonne/UChicago](#)

Development of Economical Borosilicate Capillary Arrays for MCPs – Industrial Partnership w/Incom, Inc

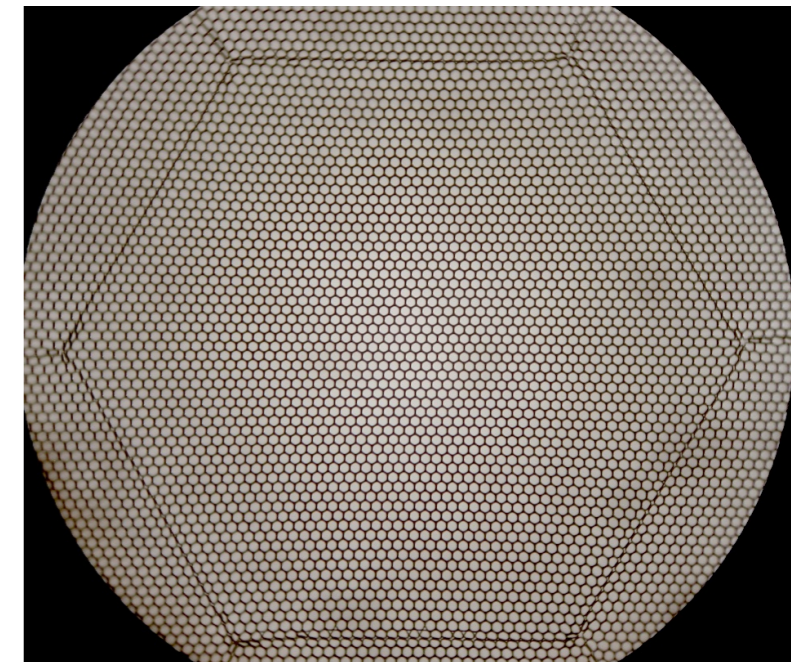
Fused block ready for slicing



First block

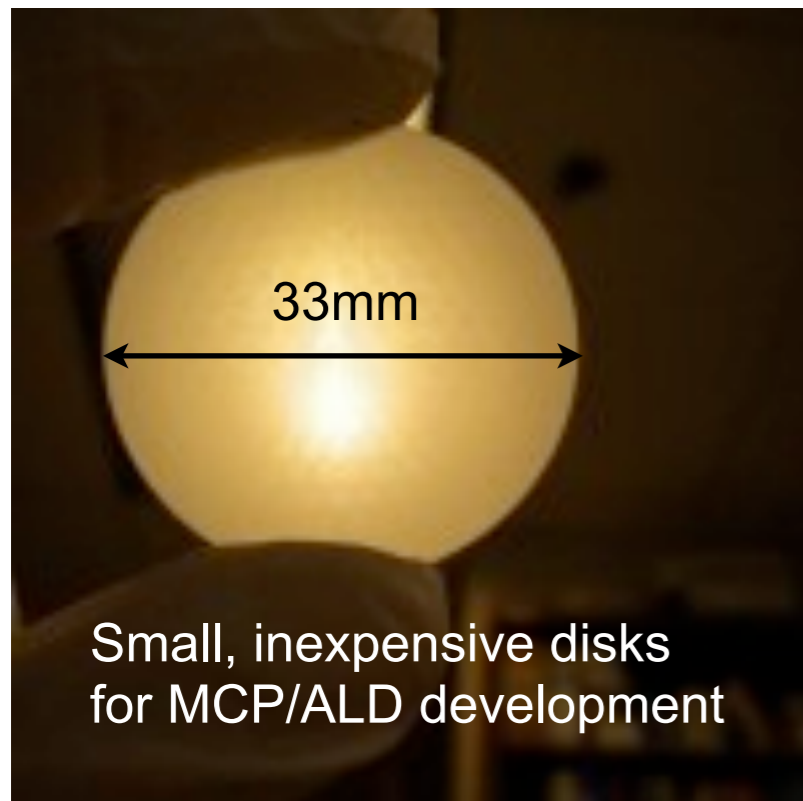


Most recent block

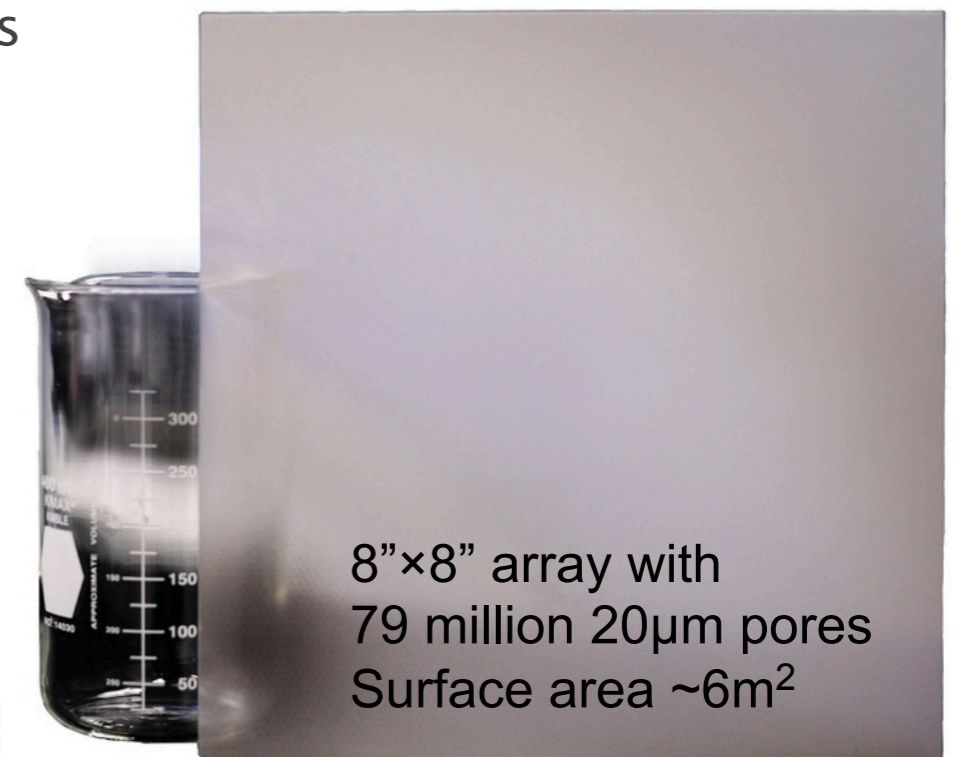


- Multifiber stacking
- Triple point gaps
- Pore crushing at multifiber boundaries

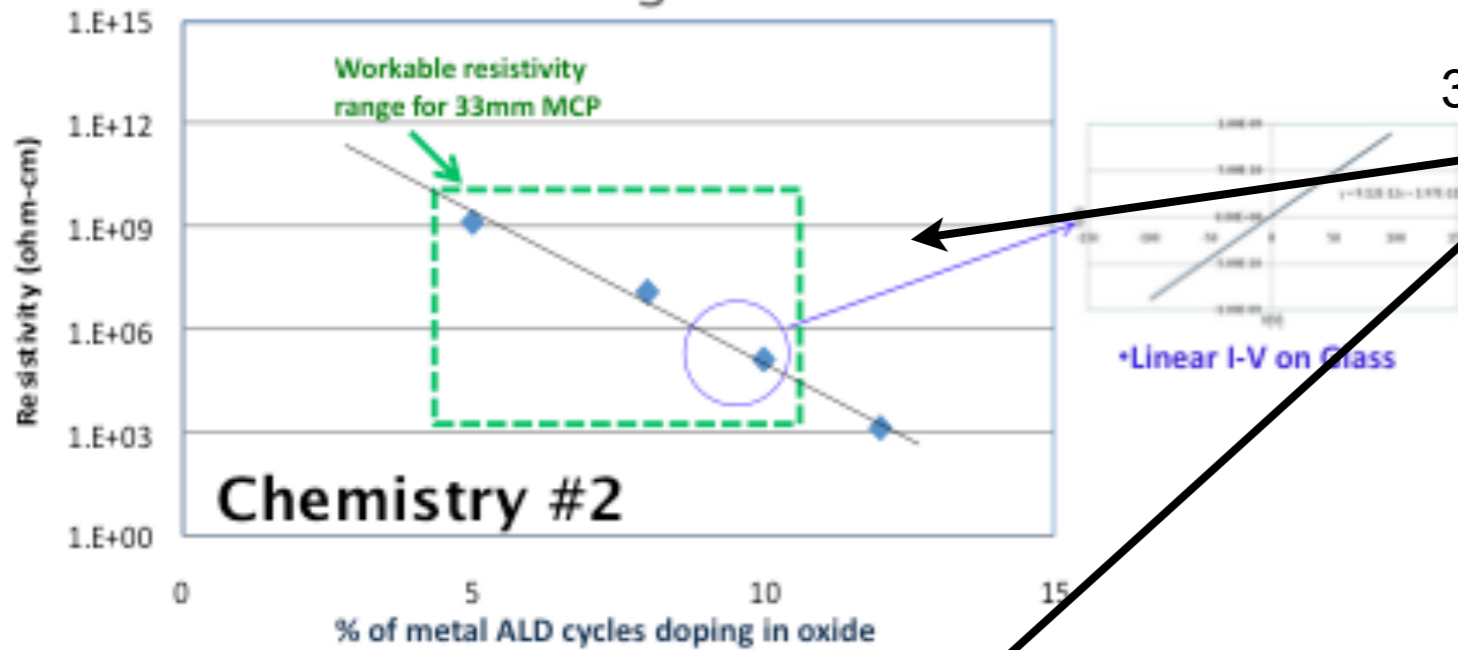
- Triple points eliminated
- Minimal boundary pore distortion



Capillary array quality dramatically improved during last 2.5 years



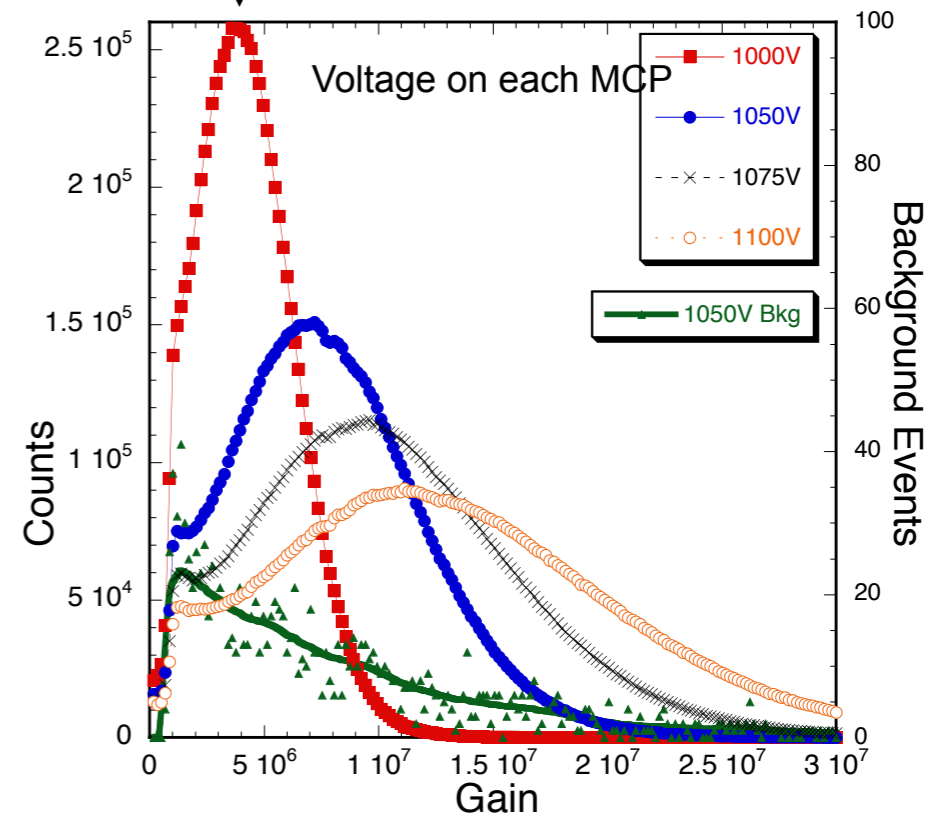
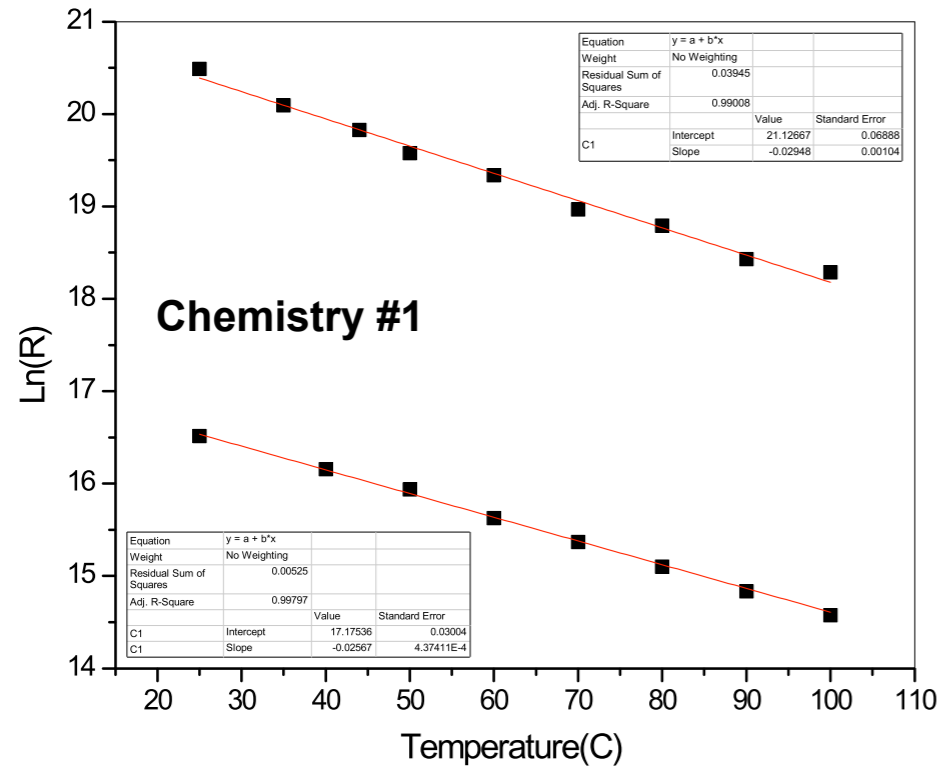
ALD Materials Development



3 Resistive Chemistries invented by ANL ALD Group:

- Tunable R over 6+ orders of mag.
- R vs. Temp. stable against thermal runaway
- Functionalized MCPs exhibit high gain

$G=4 \times 10^6$ @ 1000V



Pulse height amplitude distributions. MCP pair, 20 μ m pores, 8 $^\circ$ bias, 60:1 L/d, 0.7mm pair gap with 300V bias. 3000 sec background.

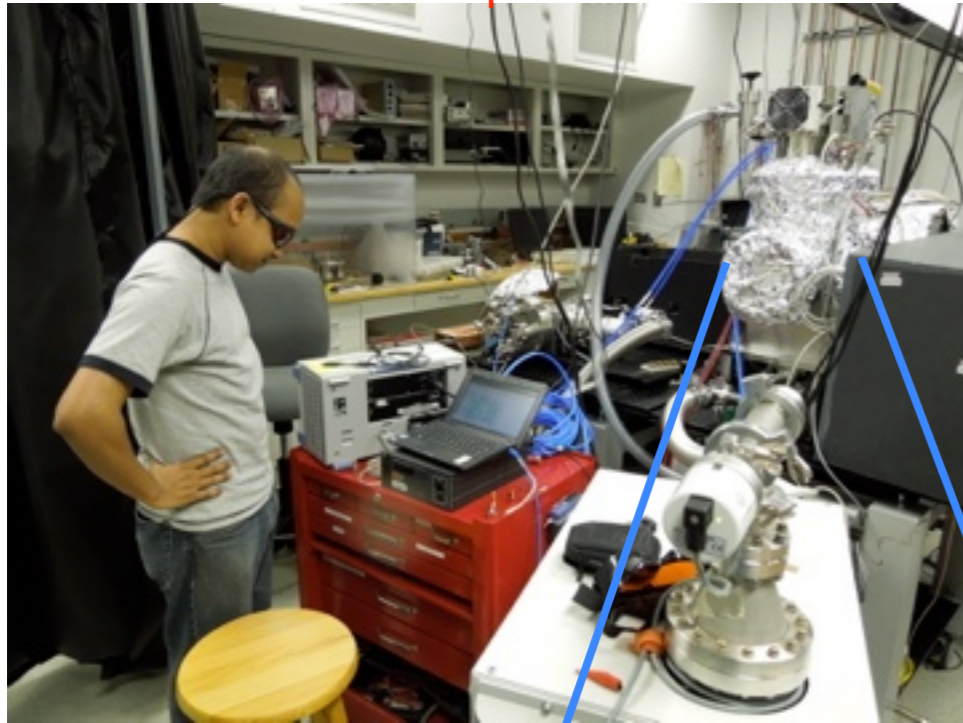
ALD development: Anil Mane & Jeff Elam, Argonne ESD

graphic: Ossy Siegmund, SSL



MCP Testing at Argonne and SSL – Facilities

Argonne 33mm & 8" Test Chambers with UV fs-pulse laser



SSL 33mm Test Chambers

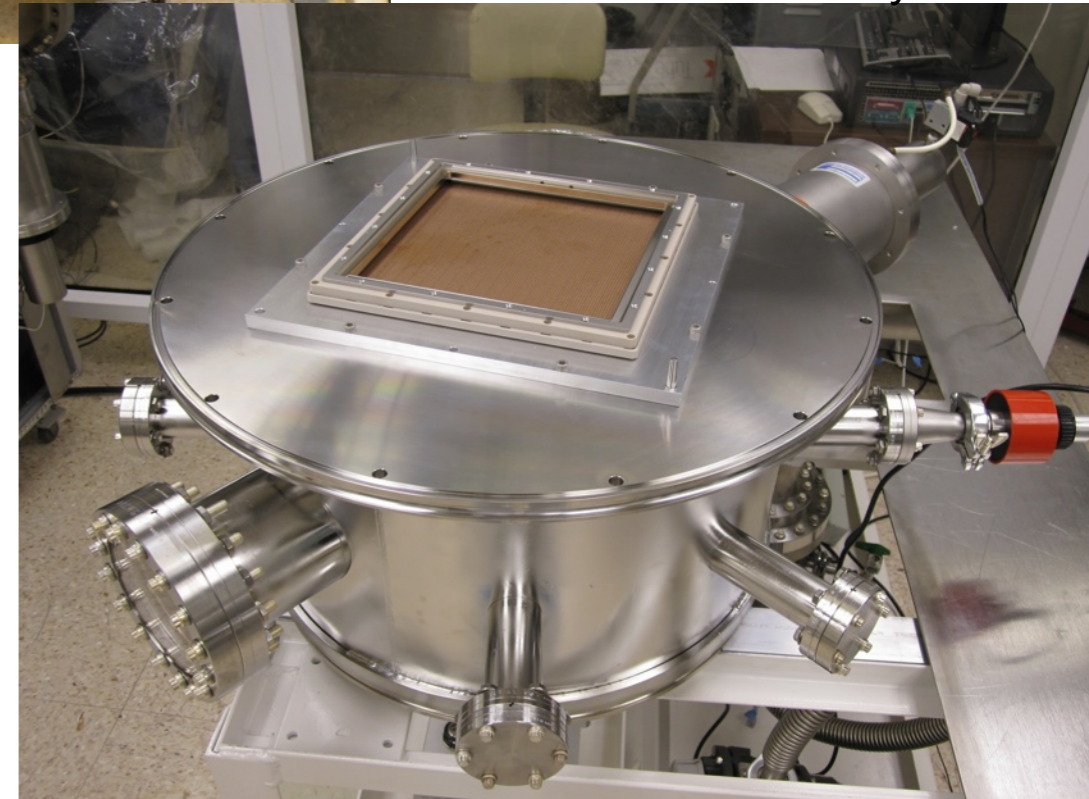
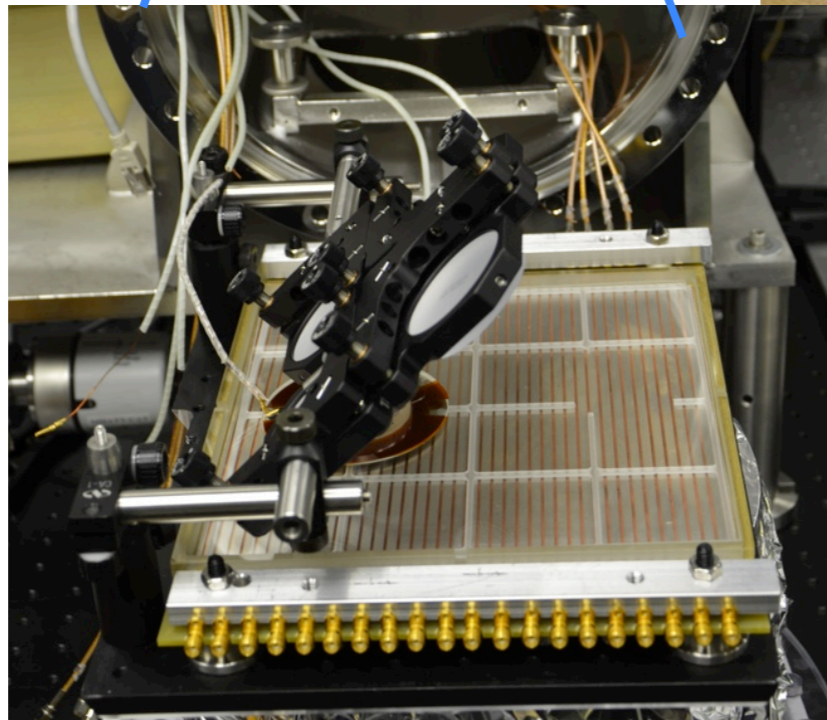


Phosphor detector on left imaged with camera

Cross-strip delay line on right for gain mapping

SSL 8" MCP Test Detector Vacuum System

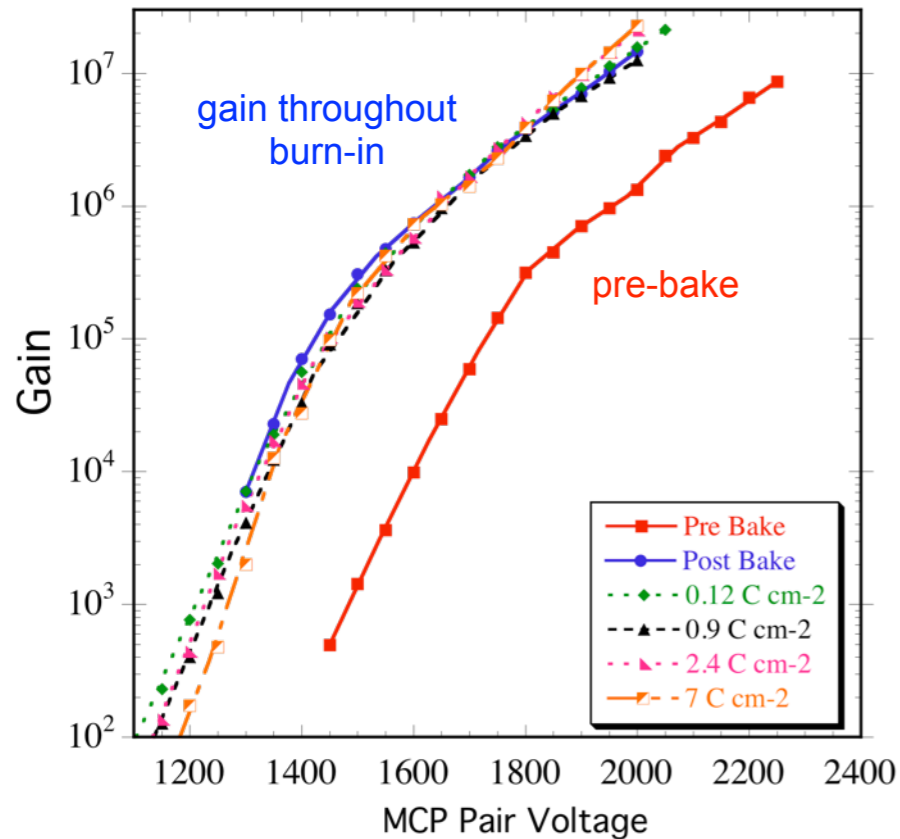
MCP on stripline anode ready for insertion into 8" chamber



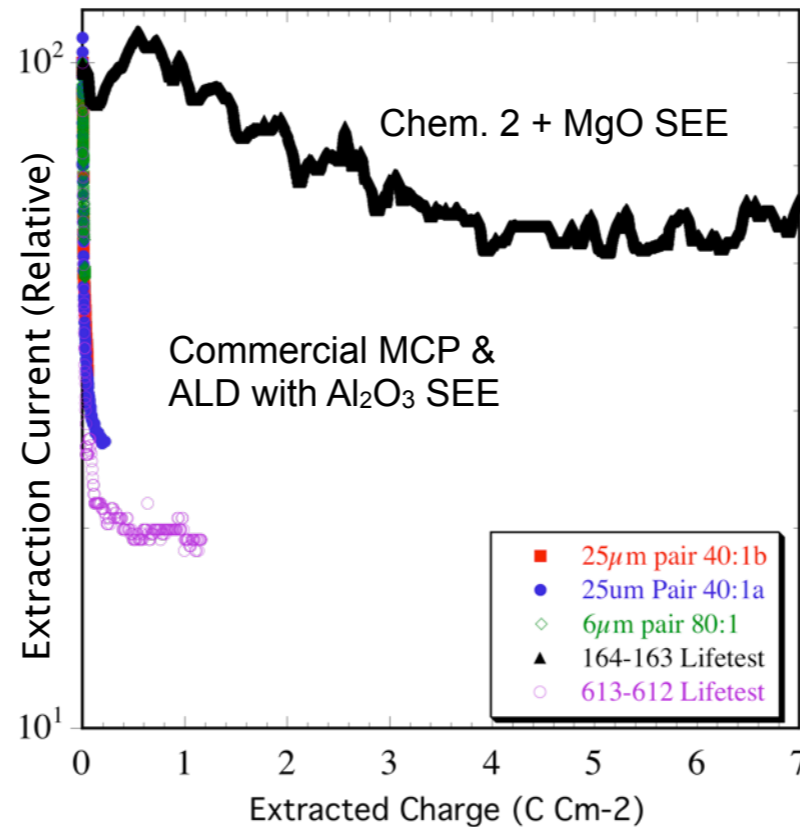
MCP Development & Testing

MCP Lifetest:

350 °C bakeout then 1-3 μA “burn-in” to 7C/cm²

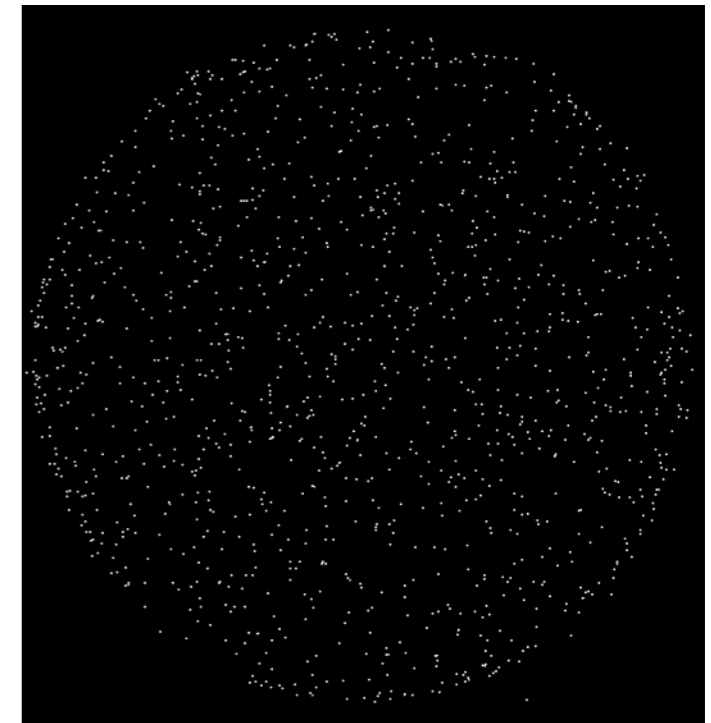


Gain curves of 33mm ALD MCP pair at stages during conditioning.



UV scrub of ALD MCP pair 164-163 compared with conventional MCPs. Outgas during burn-in <math> < 4 \times 10^{-10}</math> torr H₂.

Background Noise Measurement (separate from lifetest)



3000s bkgd, counting **0.0845 events/cm²-s**
7 x 10⁶ gain
1025v bias per MCP
300V gap bias

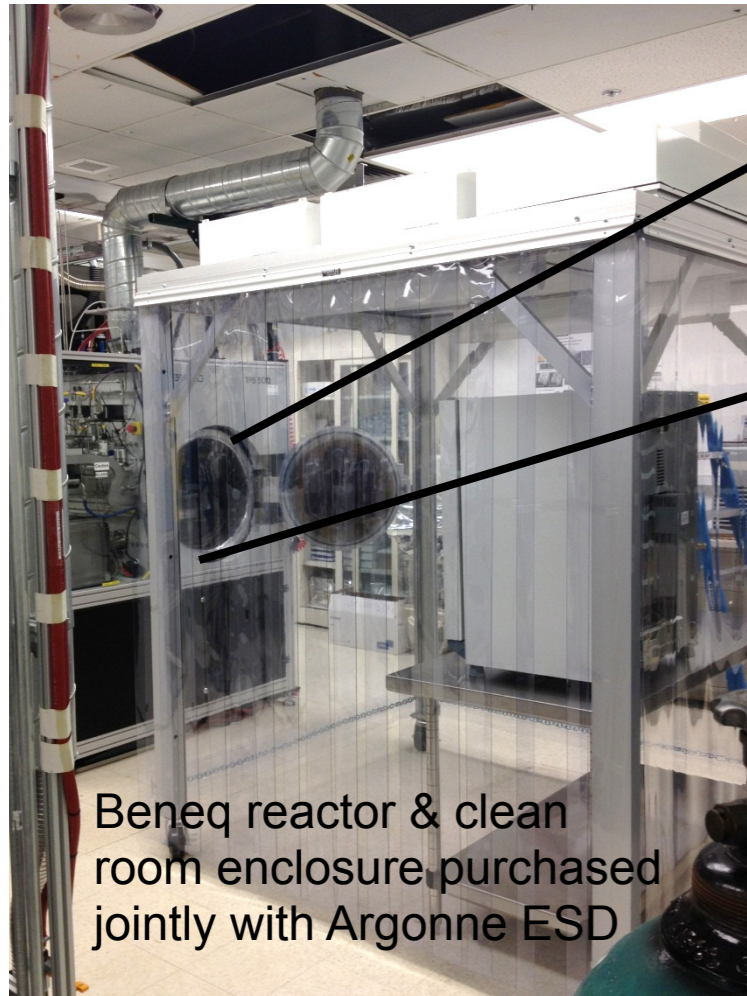
Rate comparable to cosmic bkgd

Desirable MCP properties with MgO SEE:

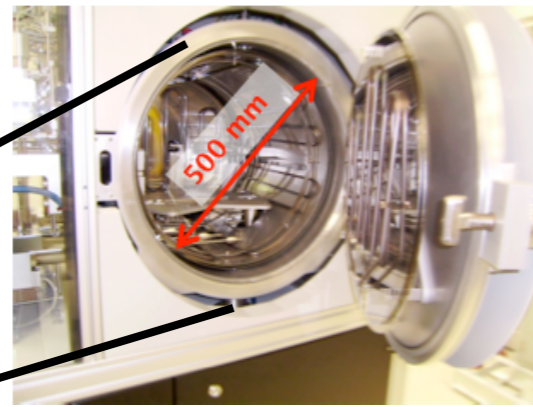
- Precipitous initial gain decrease seen in commercial MCPs absent in ALD-functionalized sample. Little or no aging up to 7C/cm².
- MgO SEE produces low-noise MCP

graphics: Ossy Siegmund & Jason McPhate, SSL

MCP Development – Scaling to Large Area



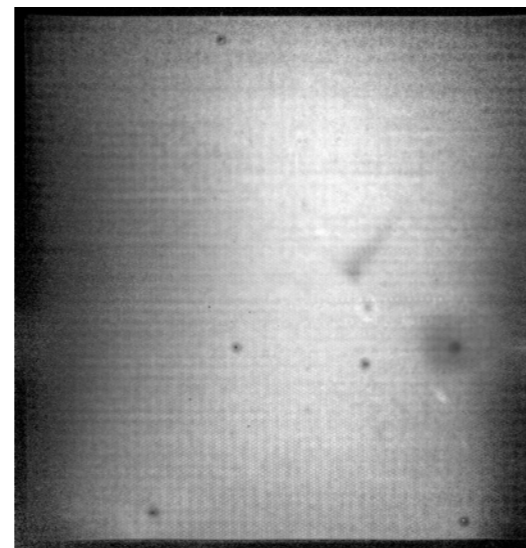
Beneq reactor & clean room enclosure purchased jointly with Argonne ESD



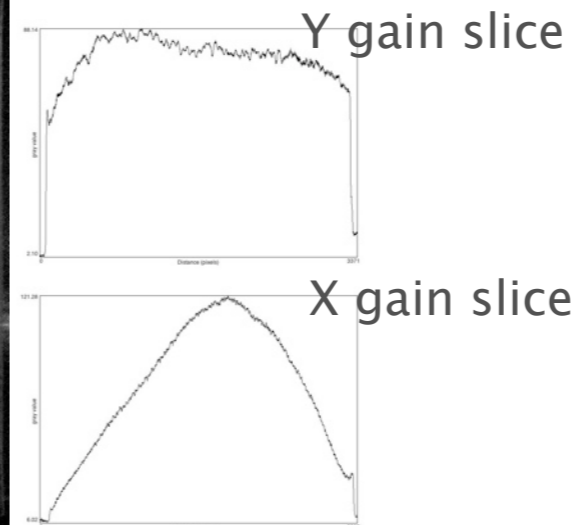
In June, 2012, Project received an **R&D 100 Award** for cost-effective and robust route to fabricate large-area MCP detectors

8" MCP Pair test at SSL

Top MCP Bias direction ←
Bottom MCP Bias direction →



1. Routinely producing targeted resistance
2. Emphasis now on SEE layer gain uniformity



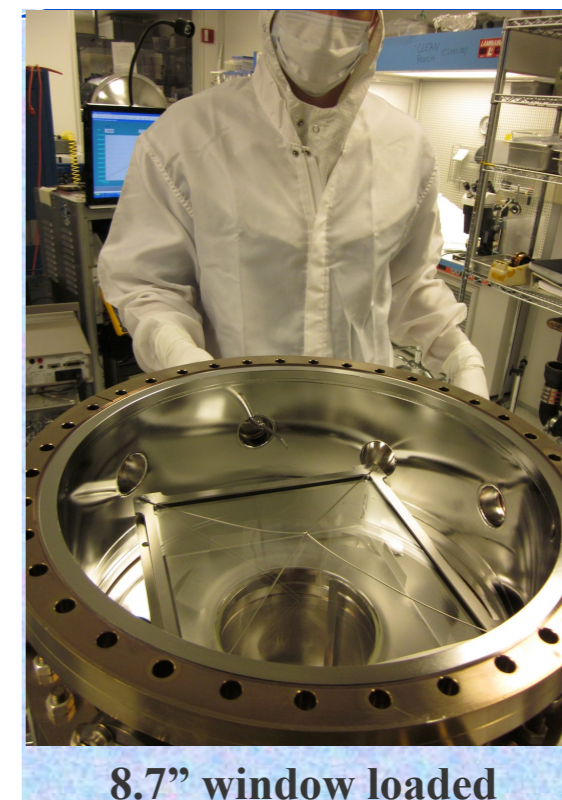
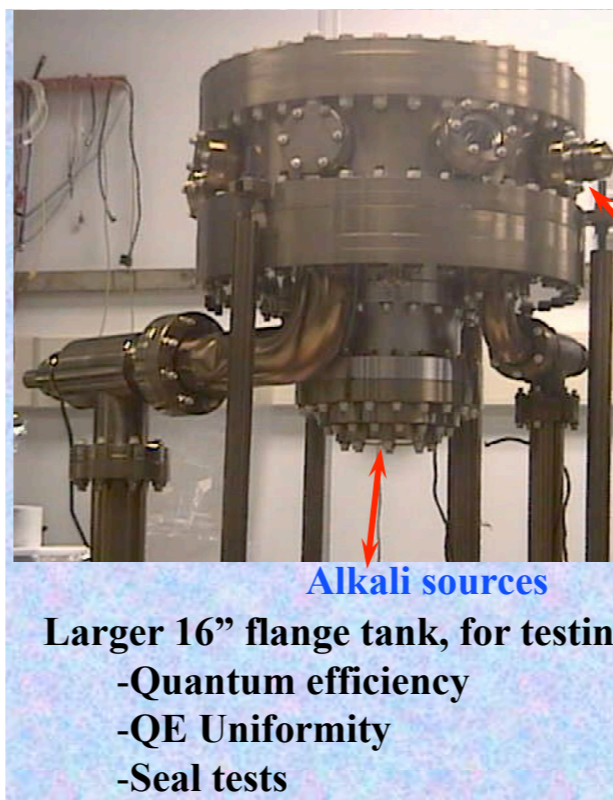
Areas of Future Focus for MCP Development

- **Near term:**
 - Tune ALD processing for uniform gain
 - Continue capillary array quality improvement
- **3 Year Plans:**
 - Increase L/D, Open-Area-Ratio; decrease pore size for improved timing
 - Develop techniques to lower plate production cost, improve finish quality
 - Explore new ALD chemistries for lower cost, higher rate

8" Photocathode Development – SSL/Berkeley

Na₂KSb Photocathode Chosen for

- Resistivity
- Noise
- Temperature robustness
- Uniformity

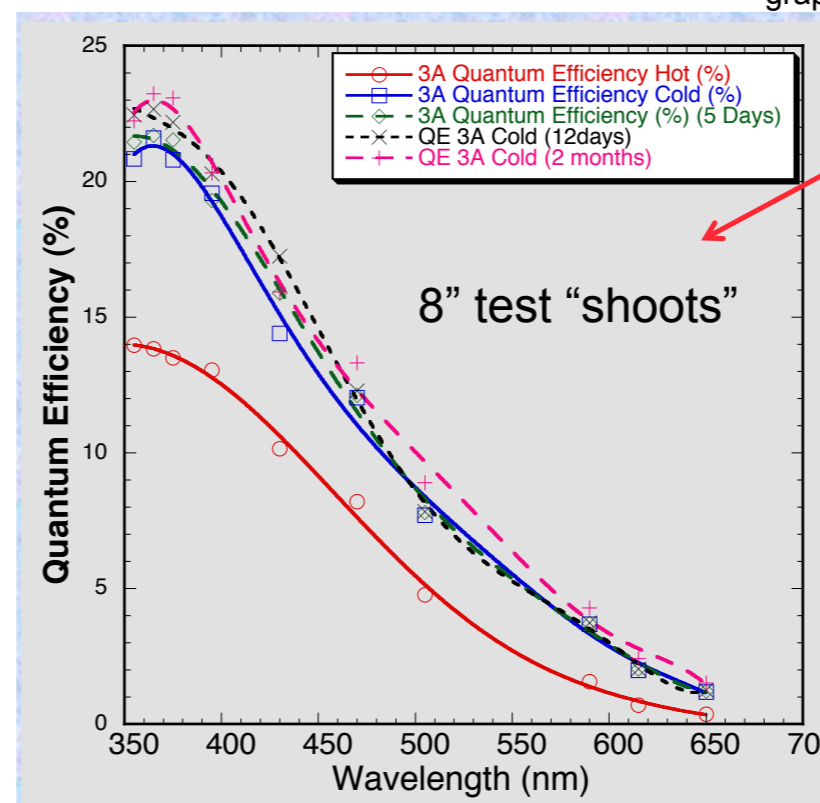


graphics: Ossy Siegmund & Jason McPhate, SSL

8" Photocathodes successfully produced at SSL

- Cathodes in 8" test chamber with QE~25%
- Uniformity and stability meet MCP tube needs
- Ready to transfer techniques from 8" test ch. to large tube processing station.

Basic process is a co-evap technique. We get an enhancement of the QE after cool-down. The QE has remained stable over the 2 months since deposition.

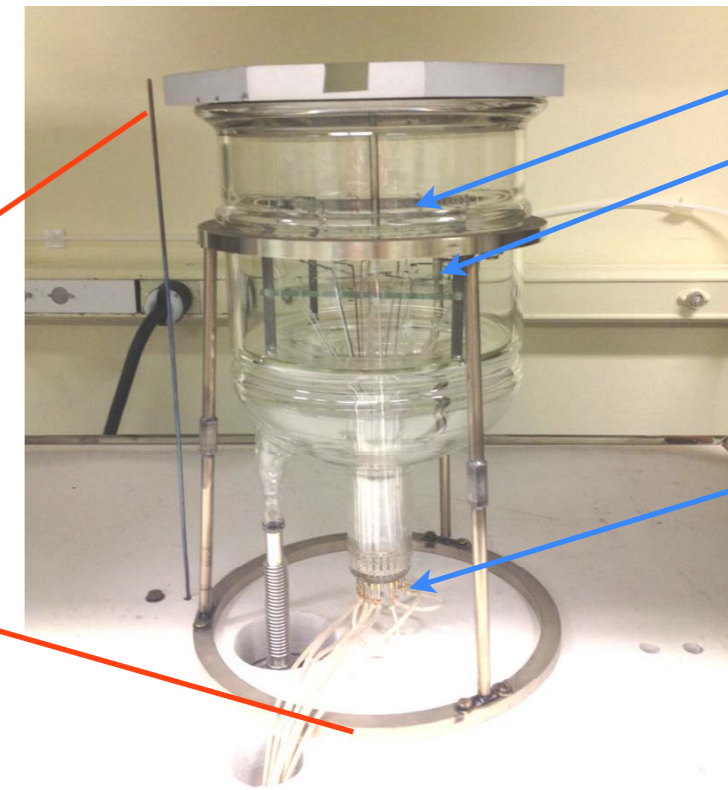
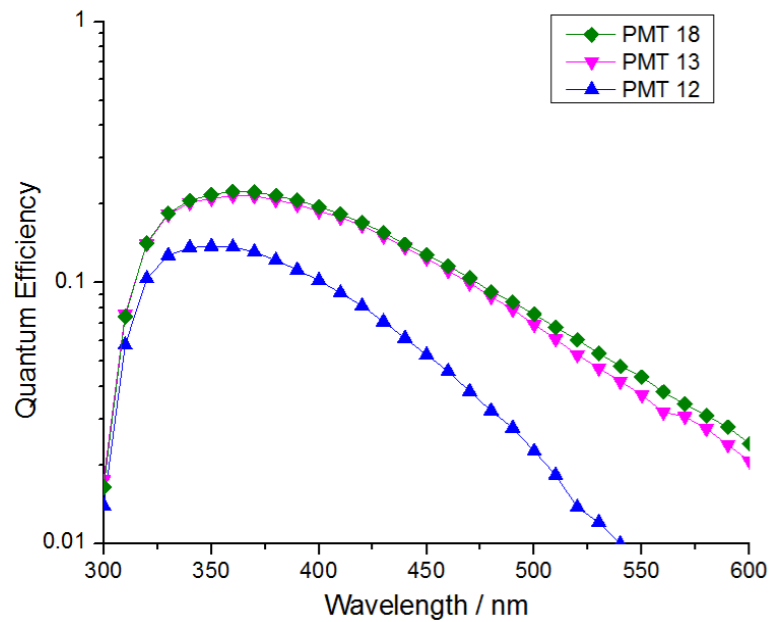


	18	22.5	14		
23	26.3	26	25.3	14.5	
	25	24.8		21.5	
19.1	25.1	24.6	23.1	23.4	21
	24.5	20		20.5	
19.5	25	23.3	22		17.5
	19.5				12
		23.7			

#3A photocathode uniformity



Photocathode Development – Argonne



Sb beads

K, Cs dispensers

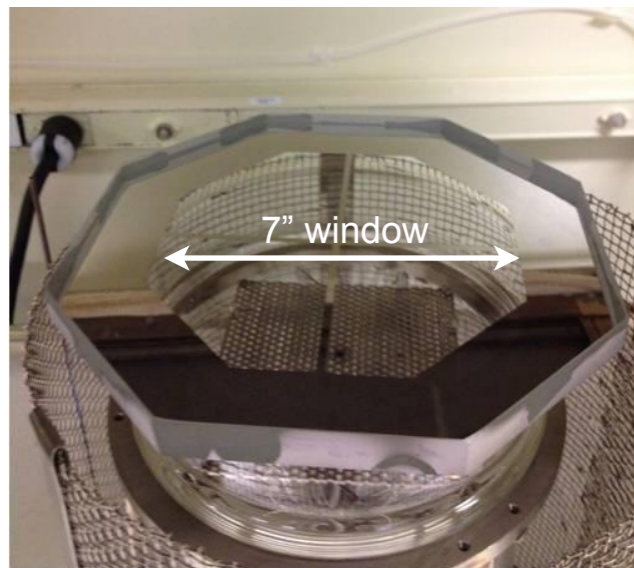
21-pin connector for beads, dispenser, signal wiring

Large glass vacuum vessel (**Chalice**) replaced small PMT manifold to produce 4" & 7" photocathodes

Developing techniques to scale to 8" transfer cathode for Tile Facility at Argonne

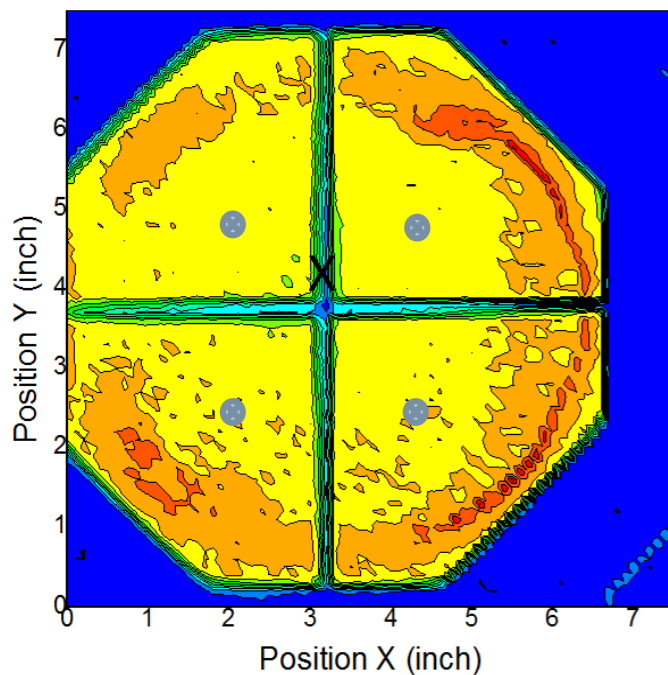
Learned photocathode fabrication techniques on phototube process system purchased from Burle

Scale-up to 7" Photocathodes at Argonne



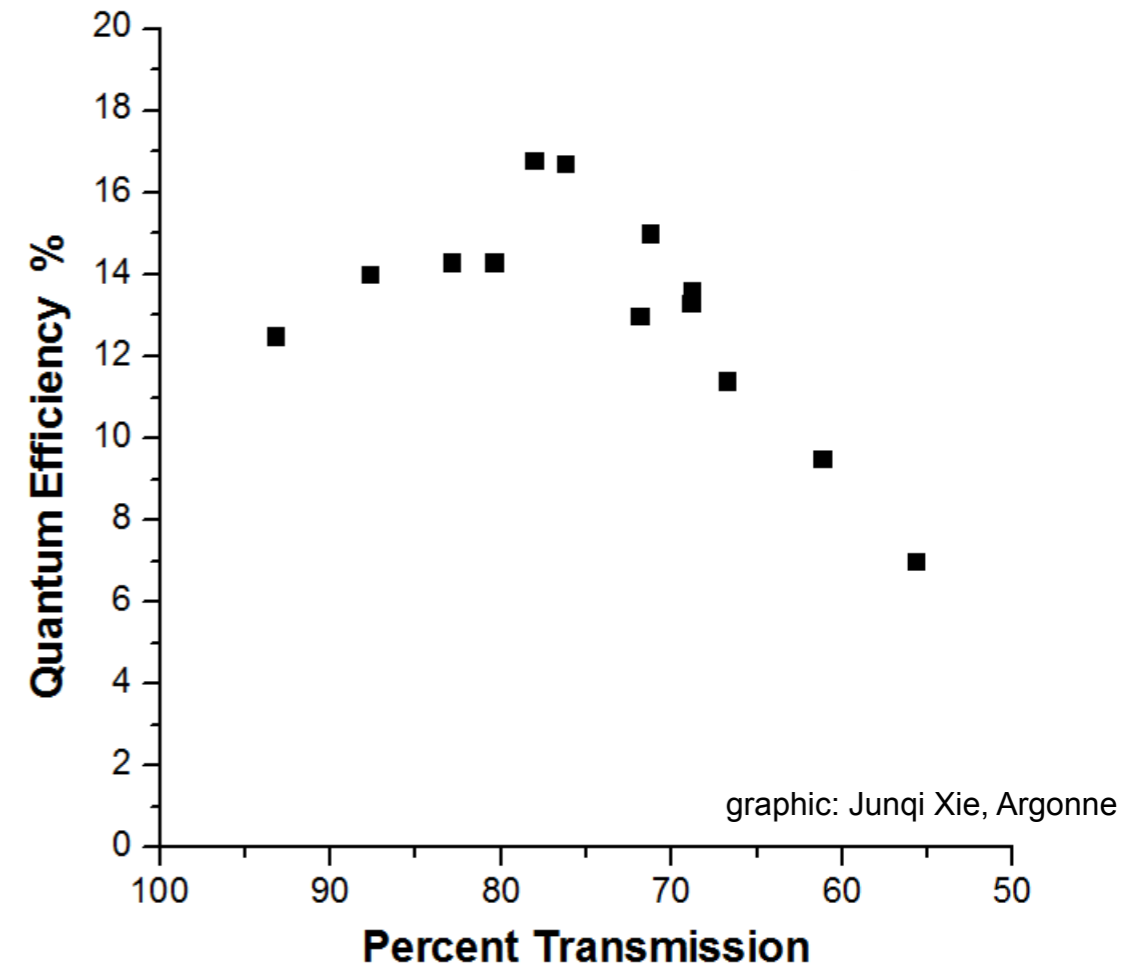
- 10 Photocathode shoots on "erasable" glass window:
- Tune process parameters
 - Optimal # and placement of Sb, K, Cs dispensers
 - Improve QE and uniformity

QE Map



Chalice Photocathode #9

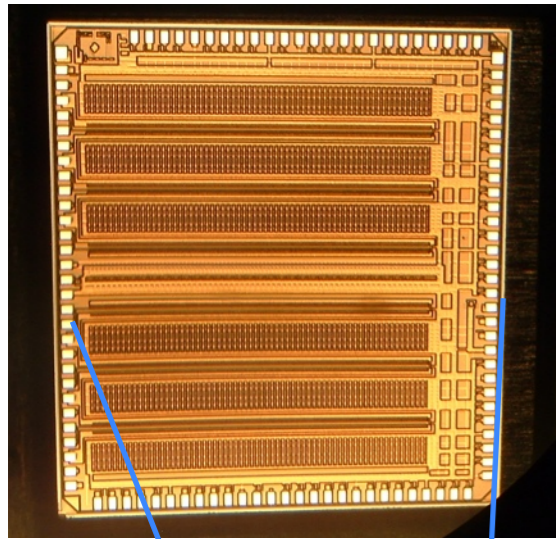
KCs-Sb Photocathode



Optimization of QE w.r.t SB thickness
% transmission of Sb \Rightarrow thickness

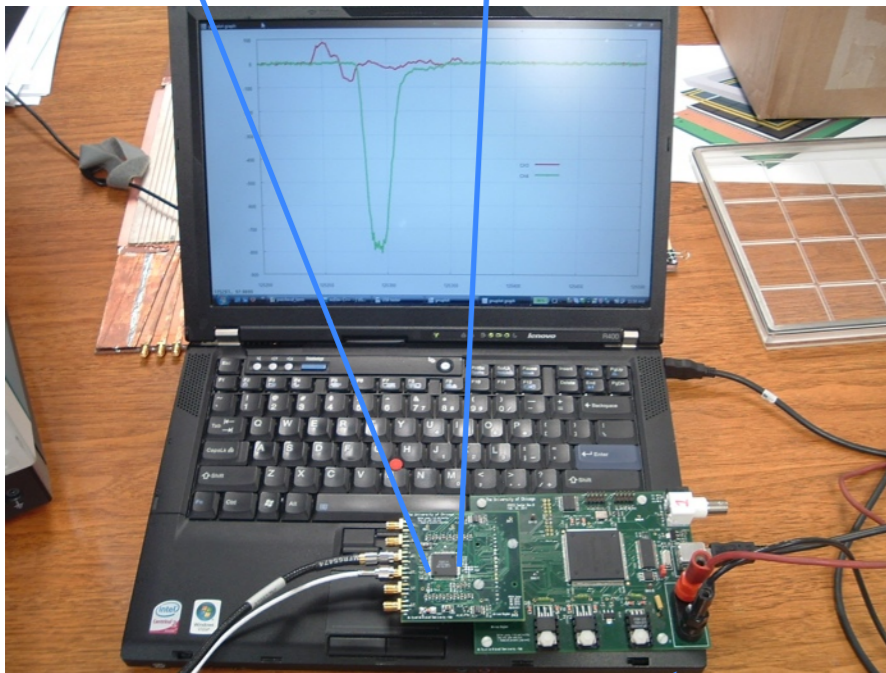
- Photocathode fabrication established at Argonne
- Ongoing study for uniformity and QE>20%
- Future focus will be to transfer techniques from Chalice to design for 8" tube processing at Argonne

Development & Testing of Front-end Electronics



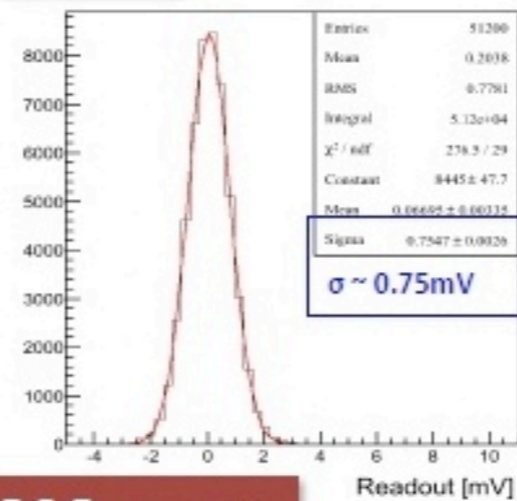
PSEC4 6-ch.
“scope-on-a-chip”
1.6 GHz BW, 10-15 GSa/s,
130nm technology

PSEC ASIC Design and Testing by
 Univ. of Chicago & Univ. of Hawaii



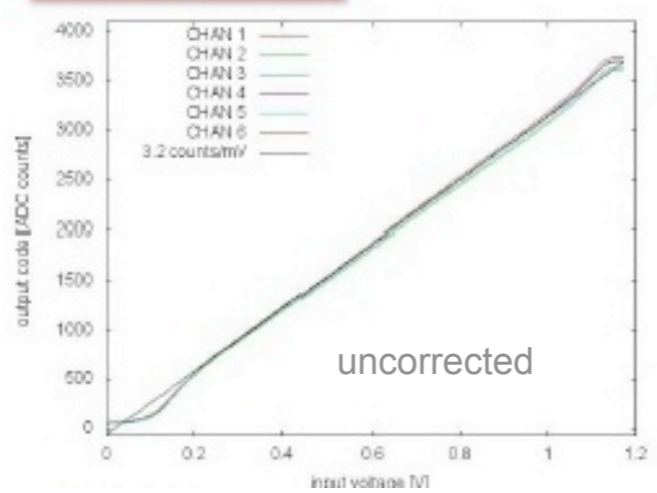
Evaluation board w/2.0 USB interface + PC DAQ software

Noise

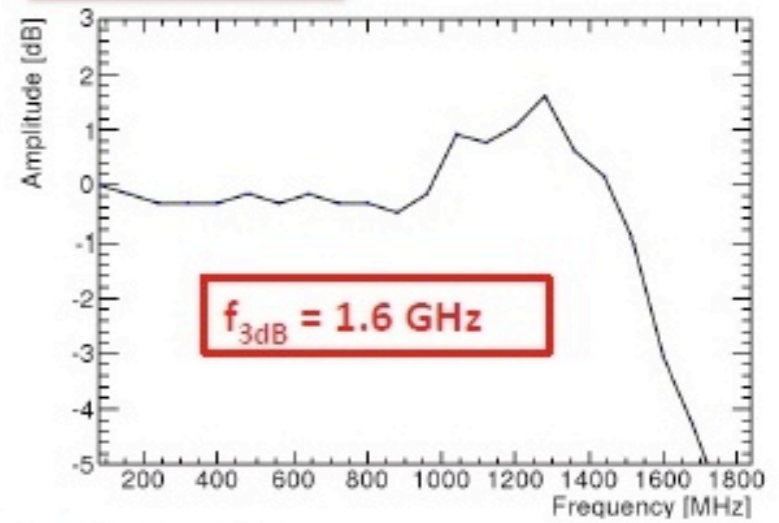


- Low noise <1 mV
- ~1V dynamic range with excellent linearity
- Analog bandwidth of 1.6 GHz
- Sampling rates up to 15 GSa/s

DC Response

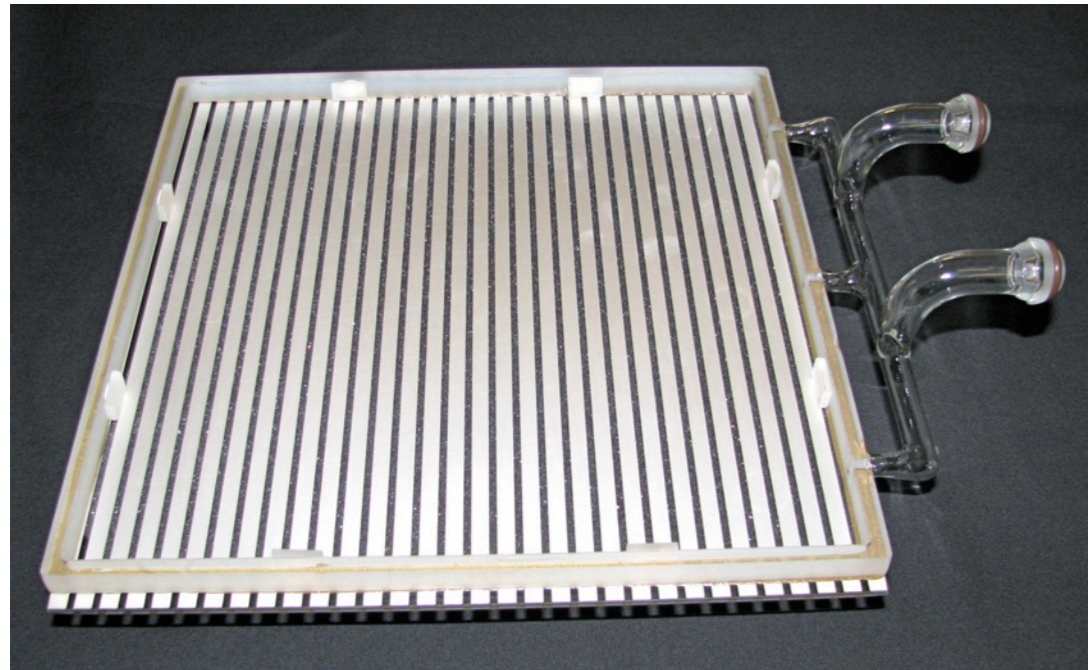


Frequency Response



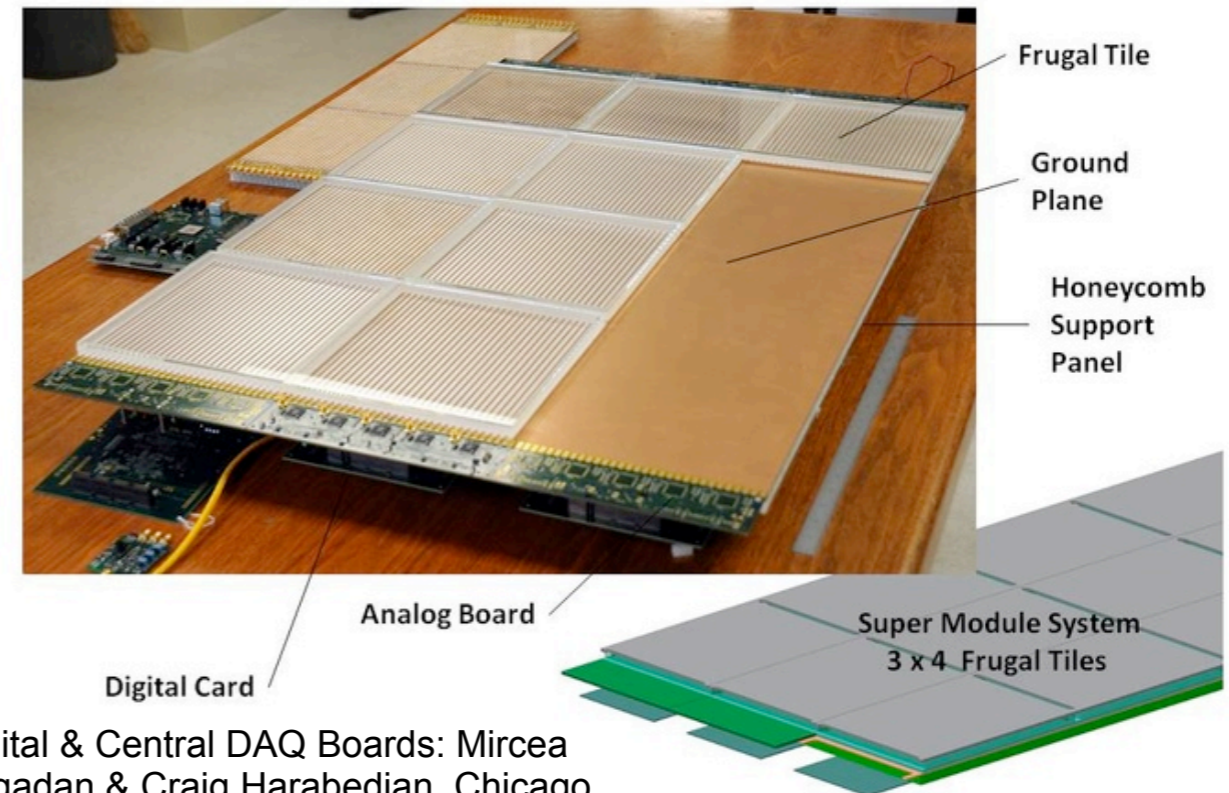
PSEC 4 design & test results: Eric Oberla & Hervé Grabas, Chicago

Glass MCP Phototube Strip Line Anode



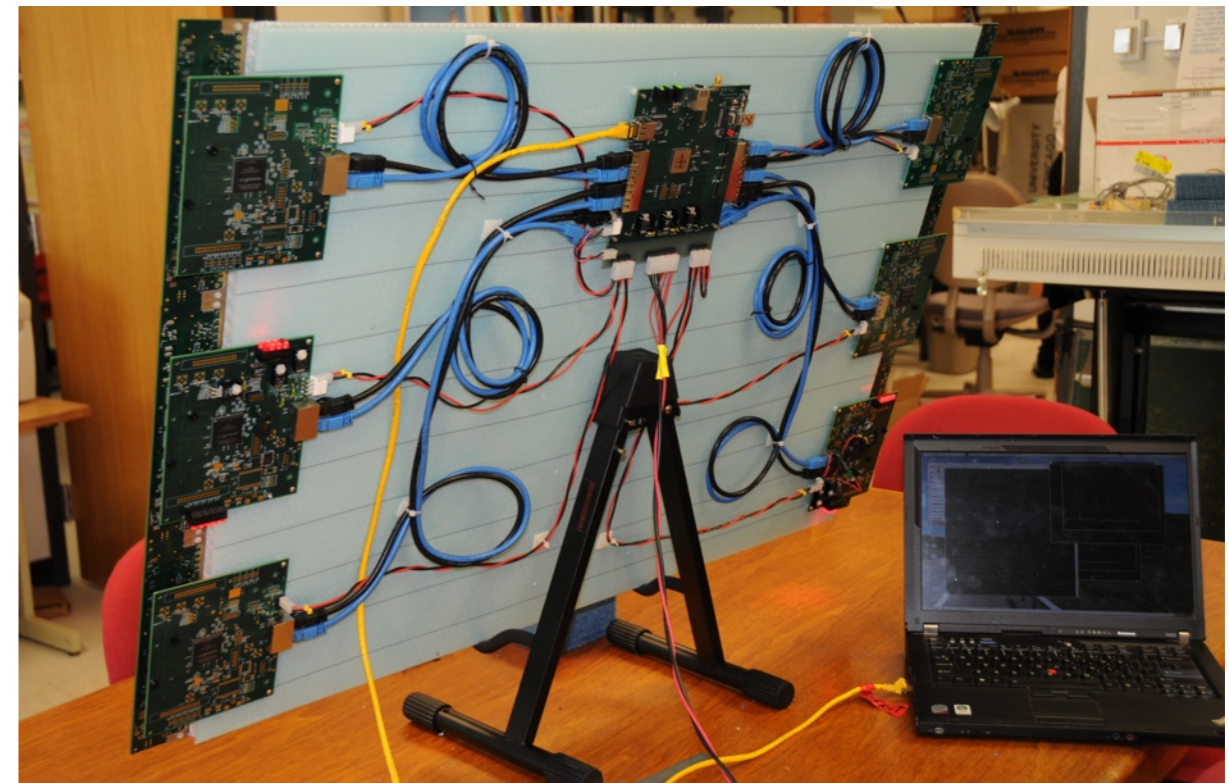
Tile base is 30 strip silk-screened anode

- One 8" MCP Glass PMT \equiv Tile
- Serial connection of tiles with common double-end readout minimally affects performance
- 4x3 array of tiles \equiv SuperModule Tray
- Complete readout chain from front-end waveform sampling ASIC through digital and central control cards to graphics processor PC has been integrated into SuperModule



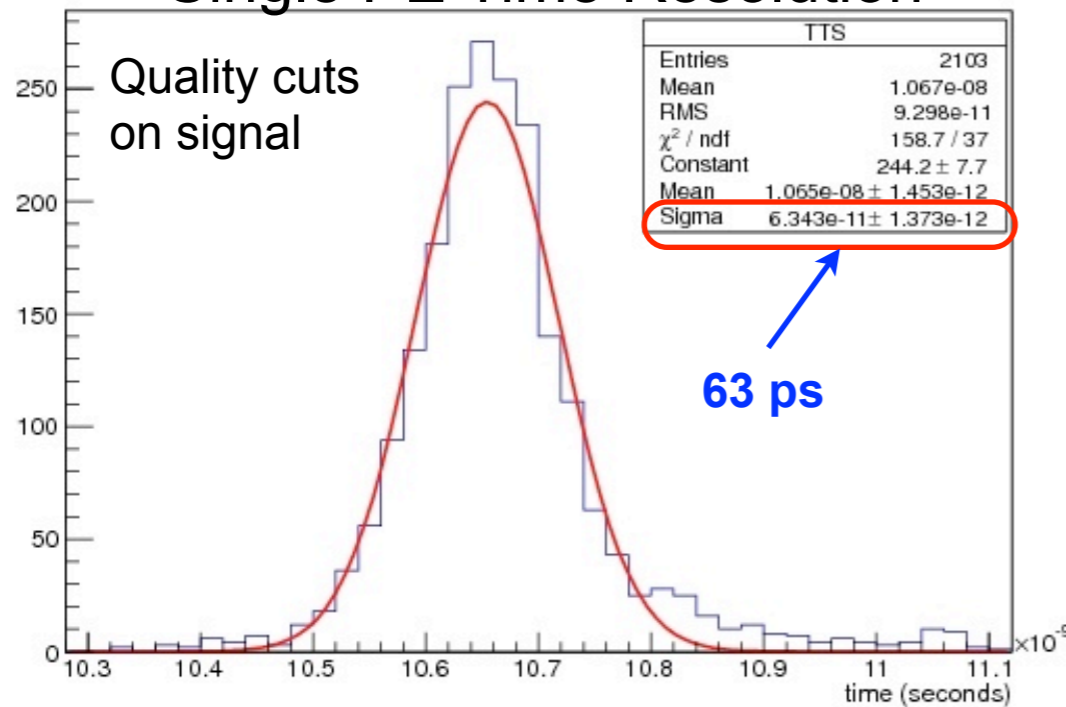
Digital & Central DAQ Boards: Mircea Bogadan & Craig Harabedian, Chicago

Tray and Tiles - The Super Module System

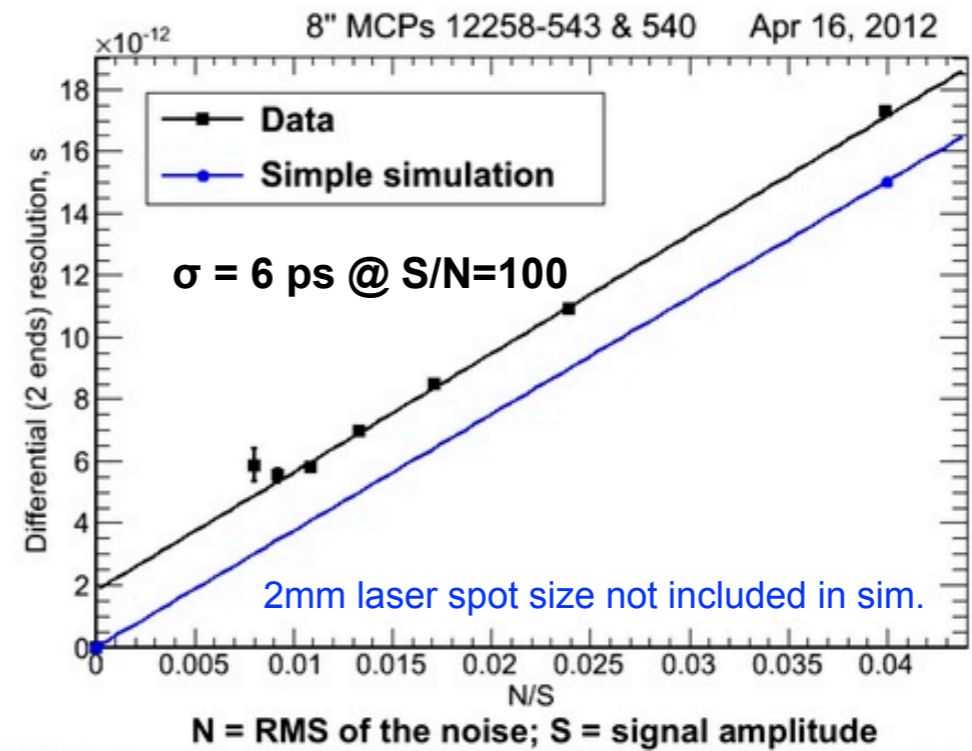


Strip Line Anode Performance with 8" MCP Pairs

Single PE Time Resolution

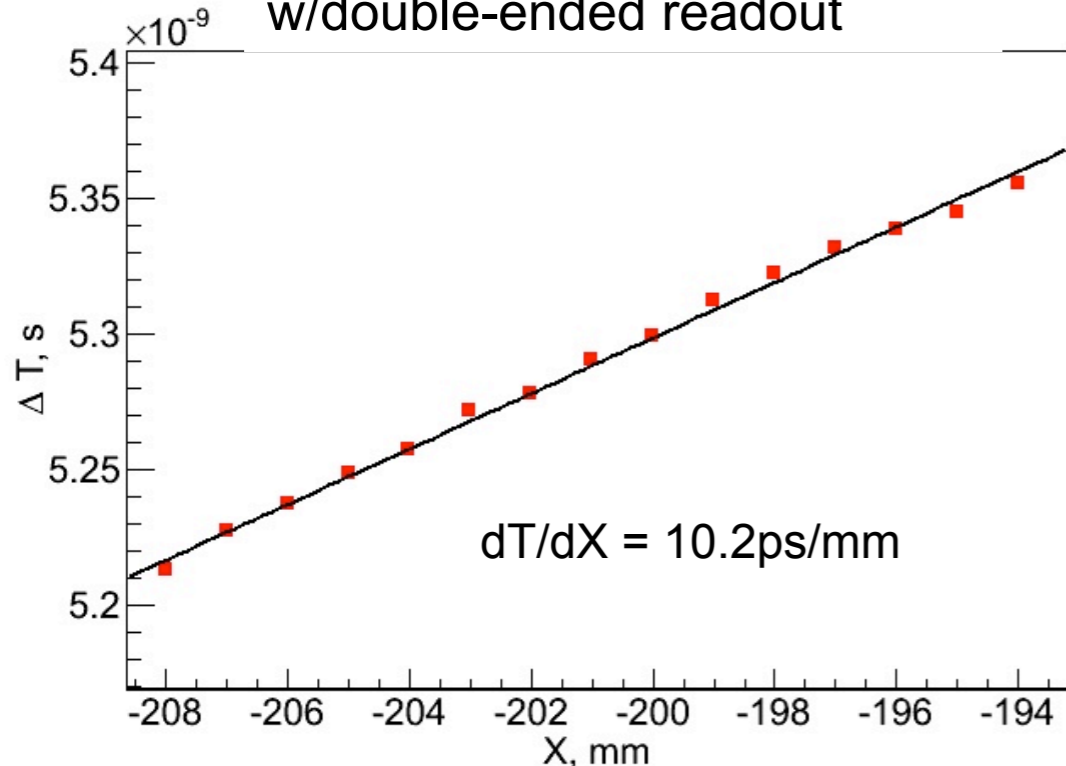


Differential Time Resolution vs. Noise



Simulation has many more points than shown. All are very well consistent with the blue line.

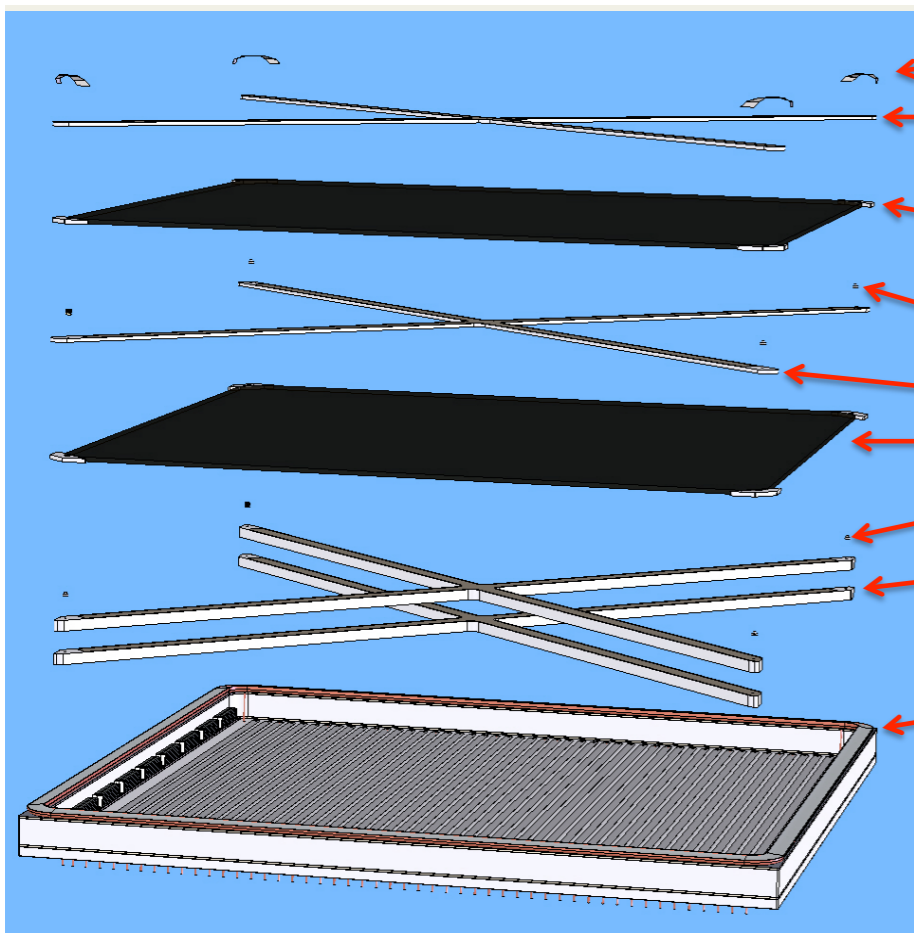
Position scan along stripline w/double-ended readout



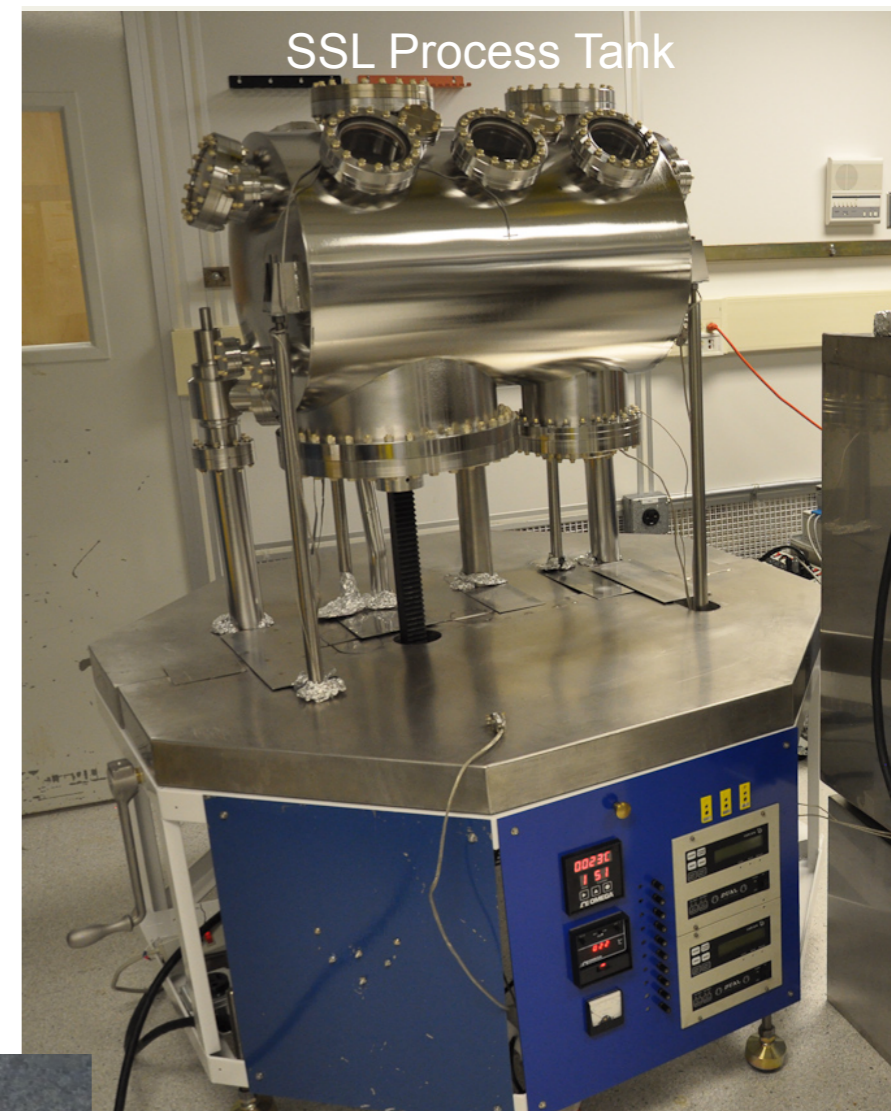
- ▶ Results from Argonne 8" Test Ch. w/UV laser excitation, fast scope readout (M.Wetstein, B. Adams, A. Elagin, R. Obaid, A. Vostrokov)
- ▶ Un-optimized Anode performance impressive and meets present needs
- ▶ Prospects for improvement to few ps resolution are good

Development of Hermetic Packaging – Ceramic Tube

Components for SSL Ceramic Tube



- Stack hold-down straps
- Top X-Grid – .060" thick plus ~.002" X-shim to adjust stack height
- Top MCP – with anti-rotation blocks at corners
- HV contacts
- Middle X-Grid – .060" thick
- Bottom MCP (w/ AR blocks)
- HV contacts
- Anode gap X-Grids - .060" ea plus ~.020" X-shim to adjust stack height
- Prepared BBA (indium and getters)
- Internal stack height .003"–.006" shorter than walls to ensure seal

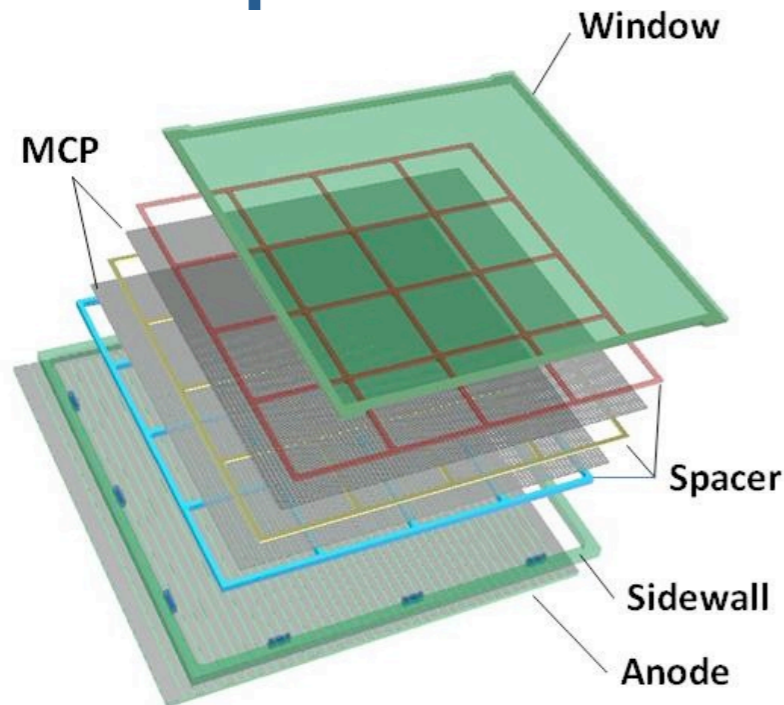


Trial detector stack-up

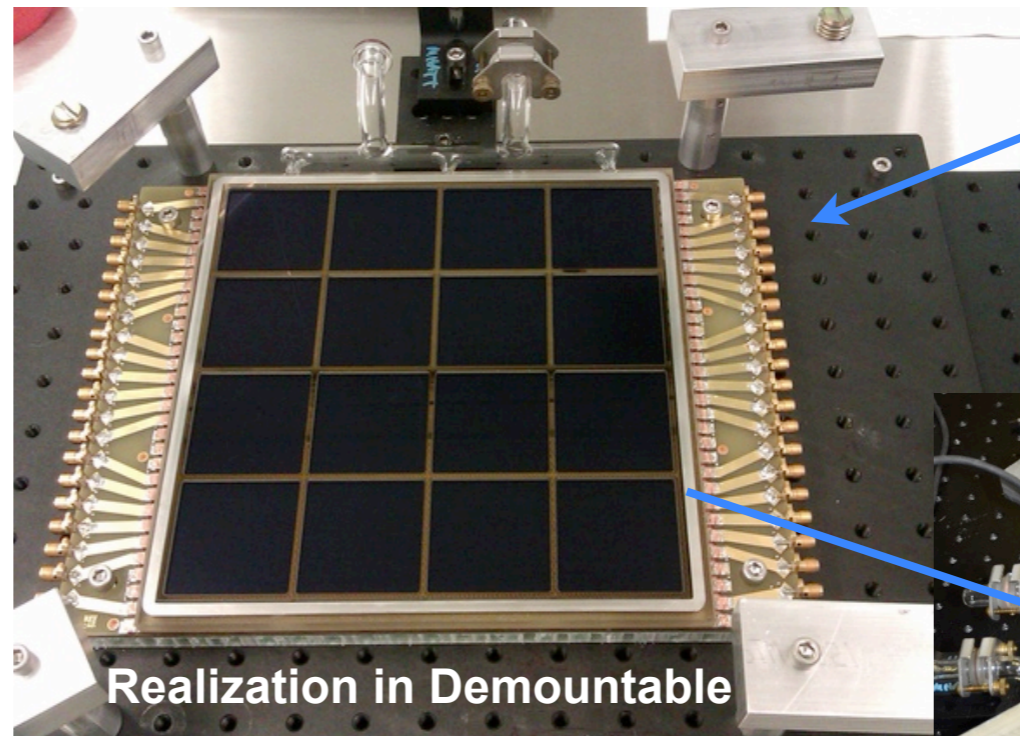


and with top window

Development of Hermetic Package – All Glass Tile



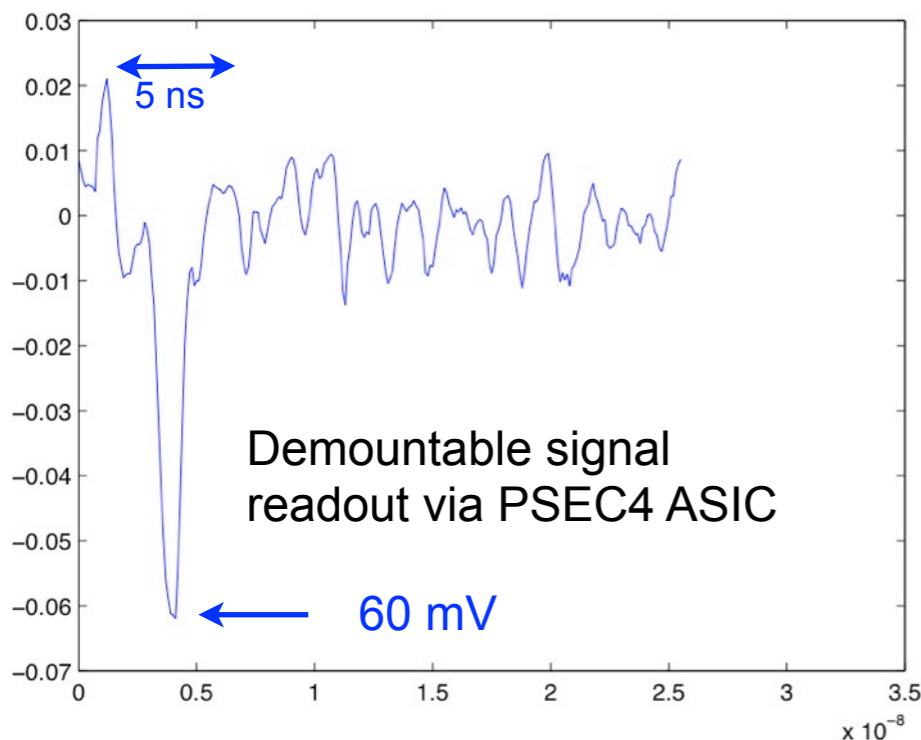
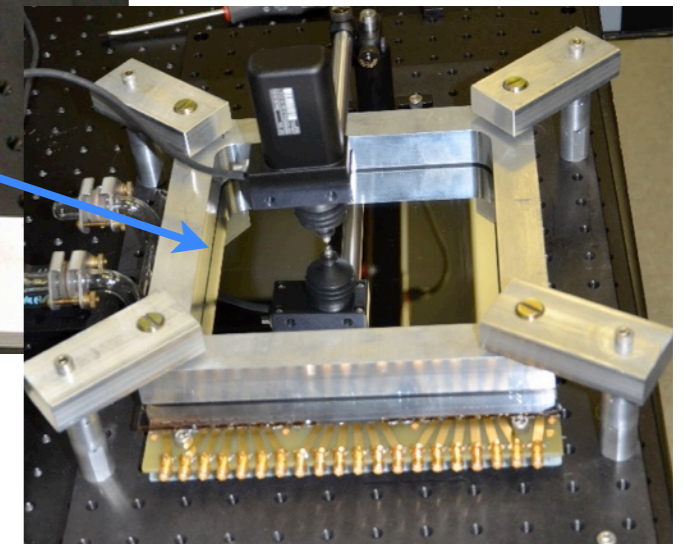
Design Drawing - September 2010



Realization in Demountable

Assembled in ALD Lab Clean Room

Transported to APS UV Laser Test Setup



Demountable is o-ring sealed tile:

- Continuously pumped
- MCP pair: Chem. 2 + MgO SEE
- Al photocathode on quartz window
- ALD grid spacer for HV distribution
- 30-strip anode to fanout board

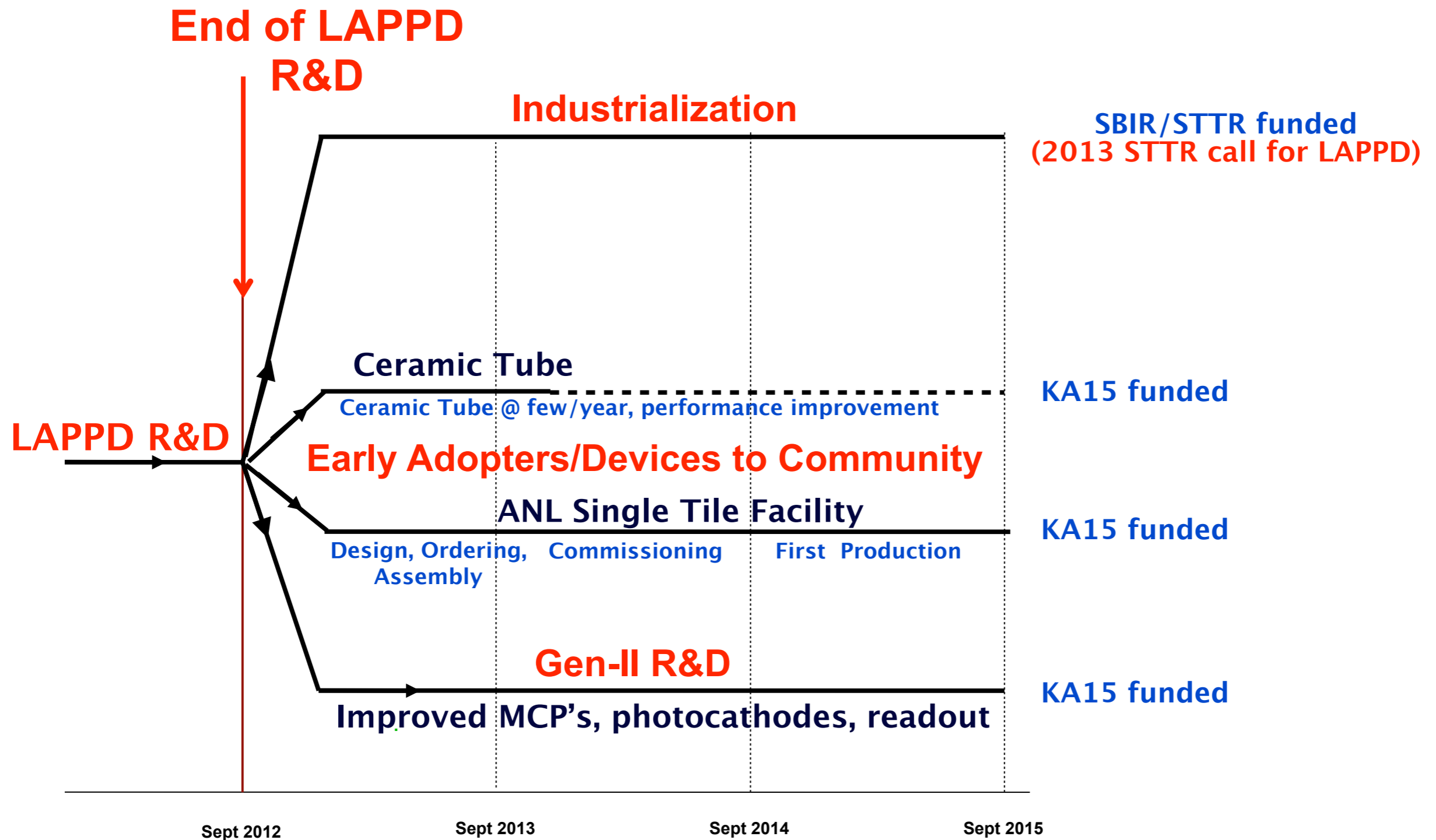
- **Concept of All-Glass Package demonstrated with signal acquisition in o-ring sealed “Demountable” Tile**
- **Future Work:**
 - Complete work presently ongoing for Indium pressure seal for top window
 - Produce sealed tiles with bialkali PC in future Argonne Single Tile Processing System

Summary of Accomplishments 2009-2012

- ☑ Developed large area capillary arrays (20 μ m pore, L/D=60) for MCP substrate
 - Functionalized MCPs via separate Atomic Layer Deposition resistive and secondary emissive coatings
 - ☑ Demonstrated high gain ($> 10^7$) with little aging
 - Success recognized with R&D100 award 2012
- ☑ Characterization of SEE materials within Argonne MSD
- ☑ Established MCP test facilities at Argonne and SSL/UC-Berkeley
- ☑ Developed detector-to-computer DAQ based on PSEC4 ASIC with 1.6GHz BW, 10-15 GSa/s
 - Timing resolution: 6ps differential, 63ps single pe
- ☑ 8" photocathodes (SSL) with QE~25% @ 350nm with good uniformity & stability
 - Established photocathode lab at Argonne and made first 4"&7" photocathodes
- ☑ Demonstrated signals from o-ring sealed all-glass economical tile at Argonne
 - Process tank for 8" ceramic tube at SSL ready for commissioning
- ➡ Completing ceramic body braze at SSL and on-track for working sealed tube in Fall 2012
- ☑ Development of 4x3 tile SuperModule tray with complete readout chain

- ☑ Original Proposal Milestone
- ➡ Milestone yet to be achieved

LAPPD Future Directions



STTR Call for LAPPD



U.S. Department of Energy

Small Business Innovation Research (SBIR) and Small Business Technology Transfer (STTR) Programs

Topics

**FY 2013
Phase I
(Release 1)**

Participating DOE Research Programs

- Office of Advanced Scientific Computing Research
- Office of Basic Energy Sciences
- Office of Biological and Environmental Research
- Office of Defense Nuclear Nonproliferation
- Office of Fusion Energy Sciences
- Office of High Energy Physics
- Office of Nuclear Physics

38. TECHNOLOGY TRANSFER OPPORTUNITY: DETECTORS (\$450,000 PHASE I / \$3,000,000 PHASE II)

Applicants to Technology Transfer Opportunities should review the section describing Technology Transfer Opportunities on page 1 of this document prior to submitting applications.

Grant applications are sought in the following subtopics:

a. Large Area Fast Photodetectors for Particle Detection (LAPPD)

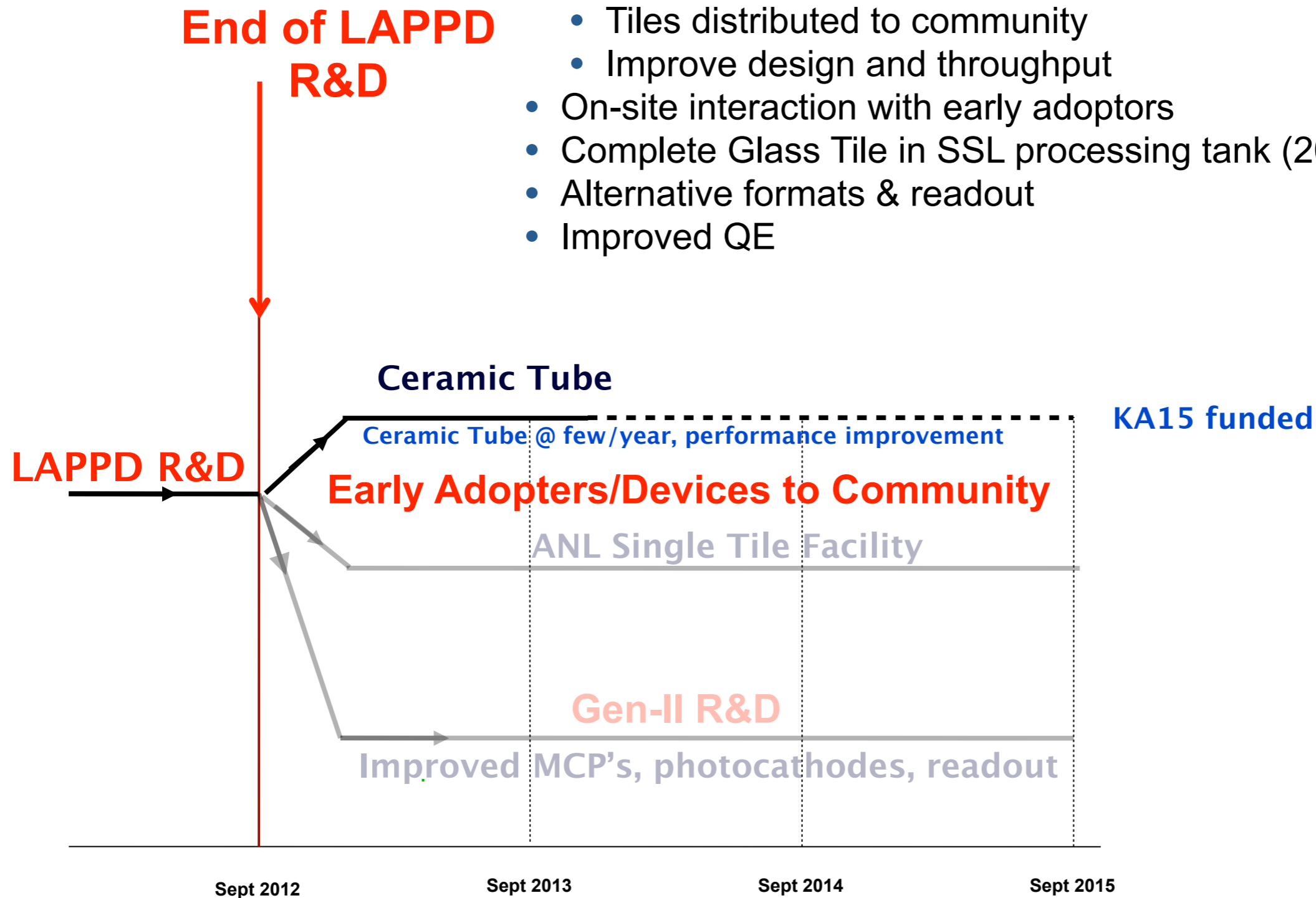
Patent Status: Two pending and unpublished patent applications and one published patent application

The LAPPD Collaboration, based at ANL, has been developing an innovative large-area (8" by 8") photodetector for use in particle physics experiments. The detectors represent an alternative to multi-channel PMTs, possibly at lower cost and with several advanced features.

LAPPD Future Directions – Ceramic Tube Production

Tile Production at SSL/UC-Berkeley:

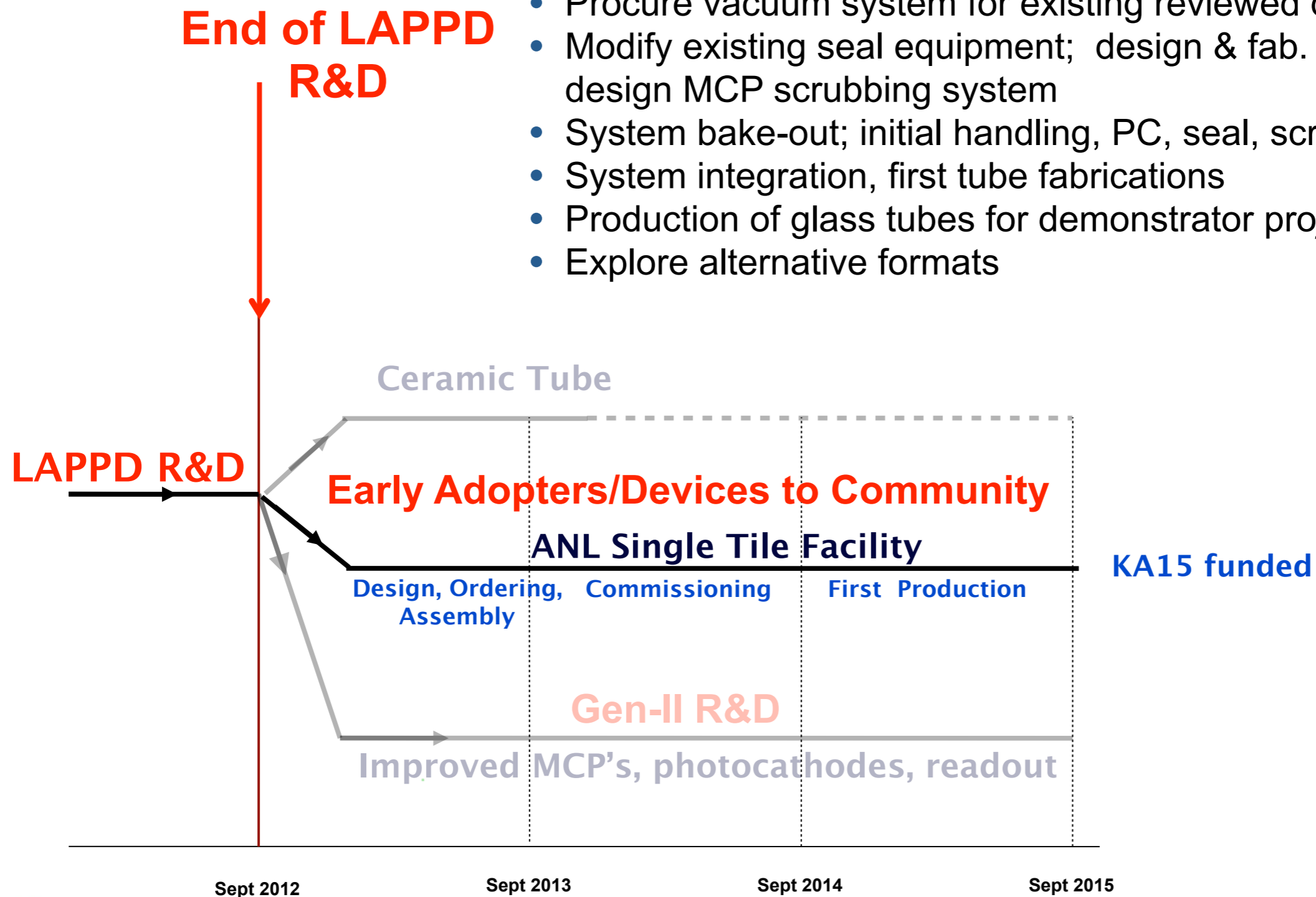
- Continue ceramic tile production @ few/year
 - Tiles distributed to community
 - Improve design and throughput
- On-site interaction with early adoptors
- Complete Glass Tile in SSL processing tank (2013)
- Alternative formats & readout
- Improved QE



LAPPD Future Directions – Argonne Single Tile Facility

Glass Tile Production at Argonne:

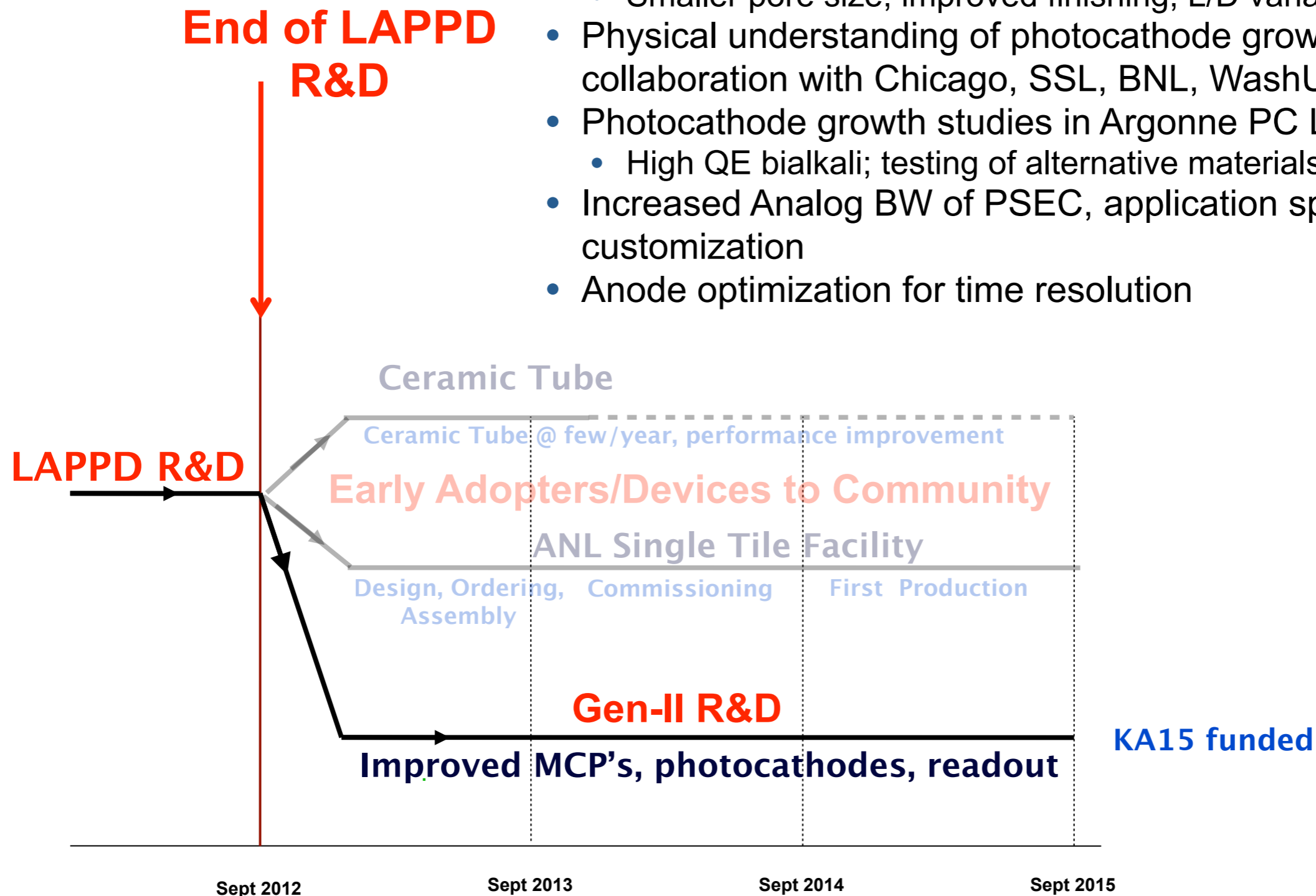
- Completion of indium seal technique
- Procure vacuum system for existing reviewed design
- Modify existing seal equipment; design & fab. PC system; design MCP scrubbing system
- System bake-out; initial handling, PC, seal, scrub tests
- System integration, first tube fabrications
- Production of glass tubes for demonstrator project
- Explore alternative formats



LAPPD Future Directions – Generation-II R&D

Gen-II R&D for Large-Area MCPs:

- Block fabrication at Incom for continued quality improvement
 - Smaller pore size, improved finishing, L/D variation
- Physical understanding of photocathode growth; collaboration with Chicago, SSL, BNL, WashU, ...
- Photocathode growth studies in Argonne PC Lab
 - High QE bialkali; testing of alternative materials, e.g. (In)GaN
- Increased Analog BW of PSEC, application specific customization
- Anode optimization for time resolution



LAPPD Project Summary

Capability Gap

- Development of large area MCP-PMTs with few ps resolution would provide a transformational tool for HEP experiments, e.g.
 - Water Č tracking detector
 - Higher momentum Particle ID
 - Pile-up vertex separation/Photon vertexing
- Existing MCPs have small effective area, are expensive, and have all properties embodied in a single medium.

Benefit

- **Cost-effective and robust technique for fabricating large-area MCPs recognized by R&D 100 award**
- **Potential for picosecond time and millimeter spatial resolution photodetection over large surface areas.**
- **Applications within and beyond HEP.**
- **Re-establish U.S. photodetector development and manufacturing.**
- **Potential large cost savings for detectors requiring 1000s of photodetectors.**

Approach

- MCP substrate, resistive, and secondary emissive components separated into less expensive individually tunable materials.
- Functionalization of MCPs via ALD.
- Develop unique, less expensive borosilicate glass hermetic package using ALD coated grid spacers for support and voltage distribution.
- Manage package risk with parallel ceramic body approach using proven techniques and expertise.
- Develop integrated DAQ w/low-power multi-ch. 15GSa/s Waveform Sampling ASIC frontend.
- Enabled by unique multi-disciplinary expertise and cross-divisional infrastructure at Argonne

Results and Deliverables

- Signals from o-ring sealed complete all-glass MCP tile
- Diff. time resolution with 8" MCP pair < 6ps
- Complete DAQ system with PSEC4 ASIC; 15 GSa/s; noise < 1mV, bandwidth ~1.6GHz
- 8" Photocathode QE~25% @ 350nm & uniform & stable
- On track for sealed ceramic MCP-PMT by Fall
- Propose to construct MCP Tile Facility at Argonne to produce all-glass tiles for evaluation by HEP community
- Continue production of ceramic tiles at SSL
- PC research to achieve QE » 25%
- Seek industrialization of photodetector; in active discussion of tech transfer with companies

Backup Slides



Applications – Photon Vertexing

Rare Kaon Decays - $K_L \rightarrow \pi^0 \nu \bar{\nu}$

Combination with precision energy resolution in calorimeter critical

Vertex $\pi^0 \rightarrow \gamma\gamma$
 $T_\nu, X_\nu, Y_\nu, Z_\nu$

Photon 1

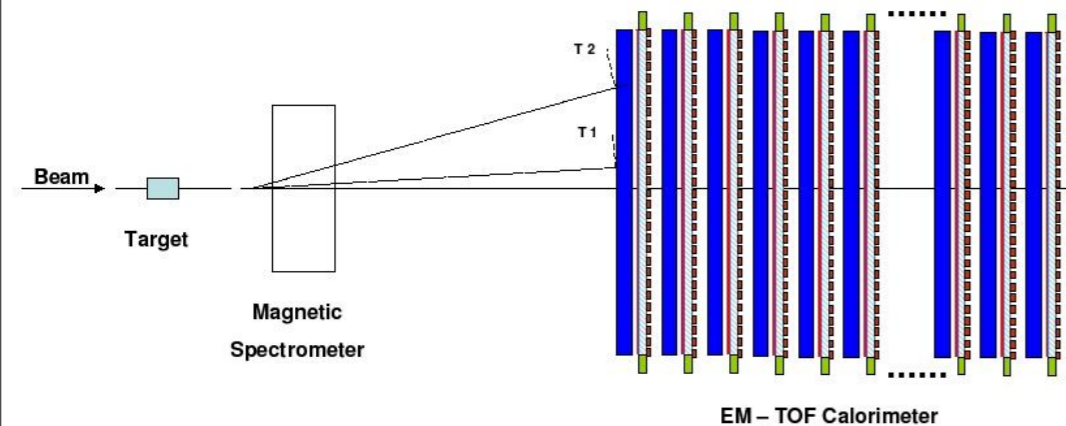
T_1, X_1, Y_1

Photon 2

T_2, X_2, Y_2

**One can reconstruct
the vertex from the
times and positions-
3D reconstruction**

MCP – based EM Sampling Calorimeter



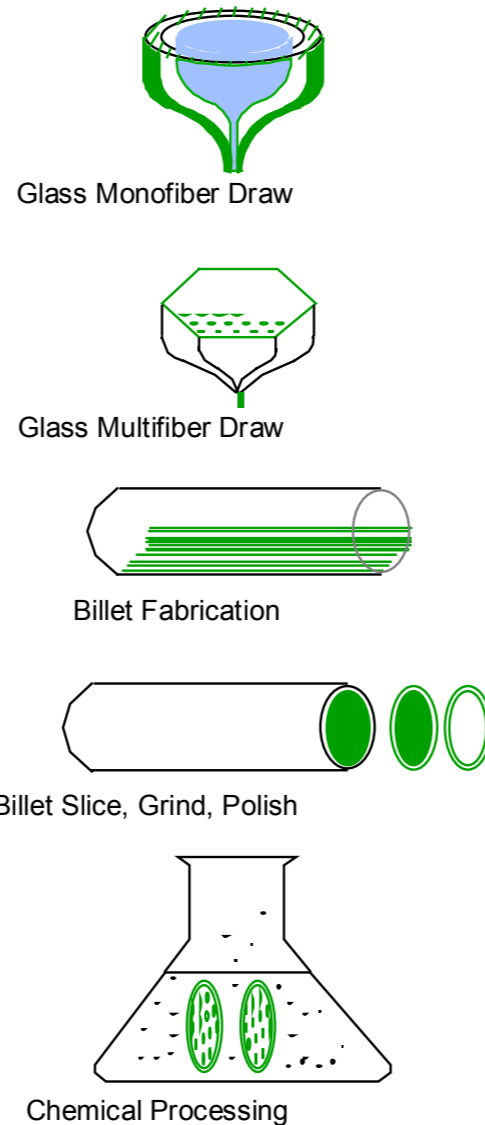
Reduce combinatoric background for π^0

Industrial Microchannel Plate Fabrication

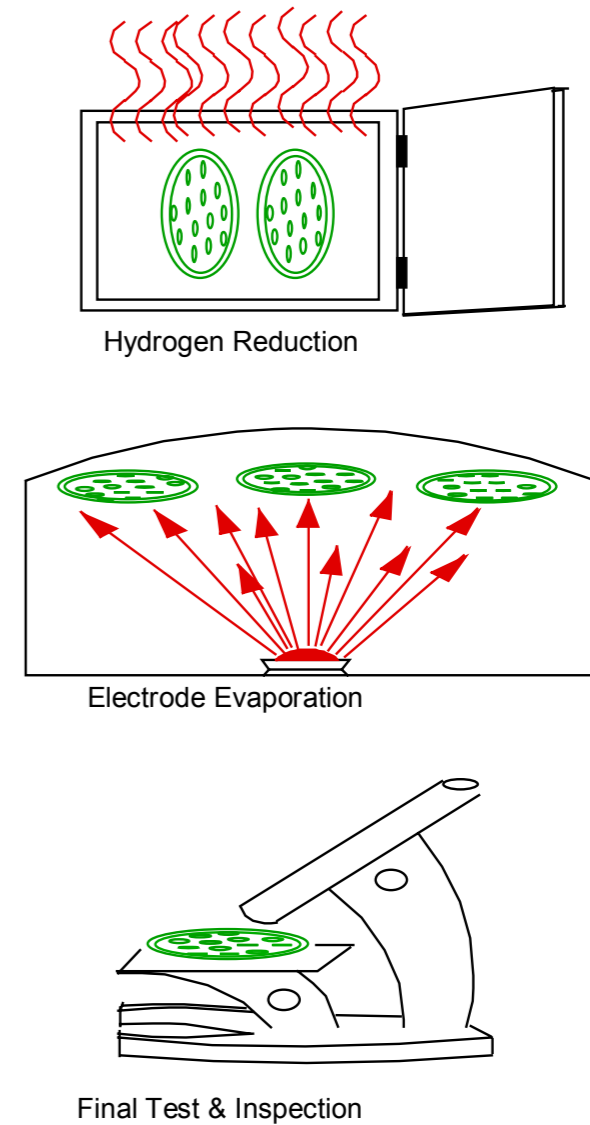
Glass is gravity-fed via cylindrical furnace

Glass is typically lead glass tube with solid soft glass core

Chemical processing to remove soft core glass



Graphic Credit: B. Laprade & R. Starcher, Burle (2001)

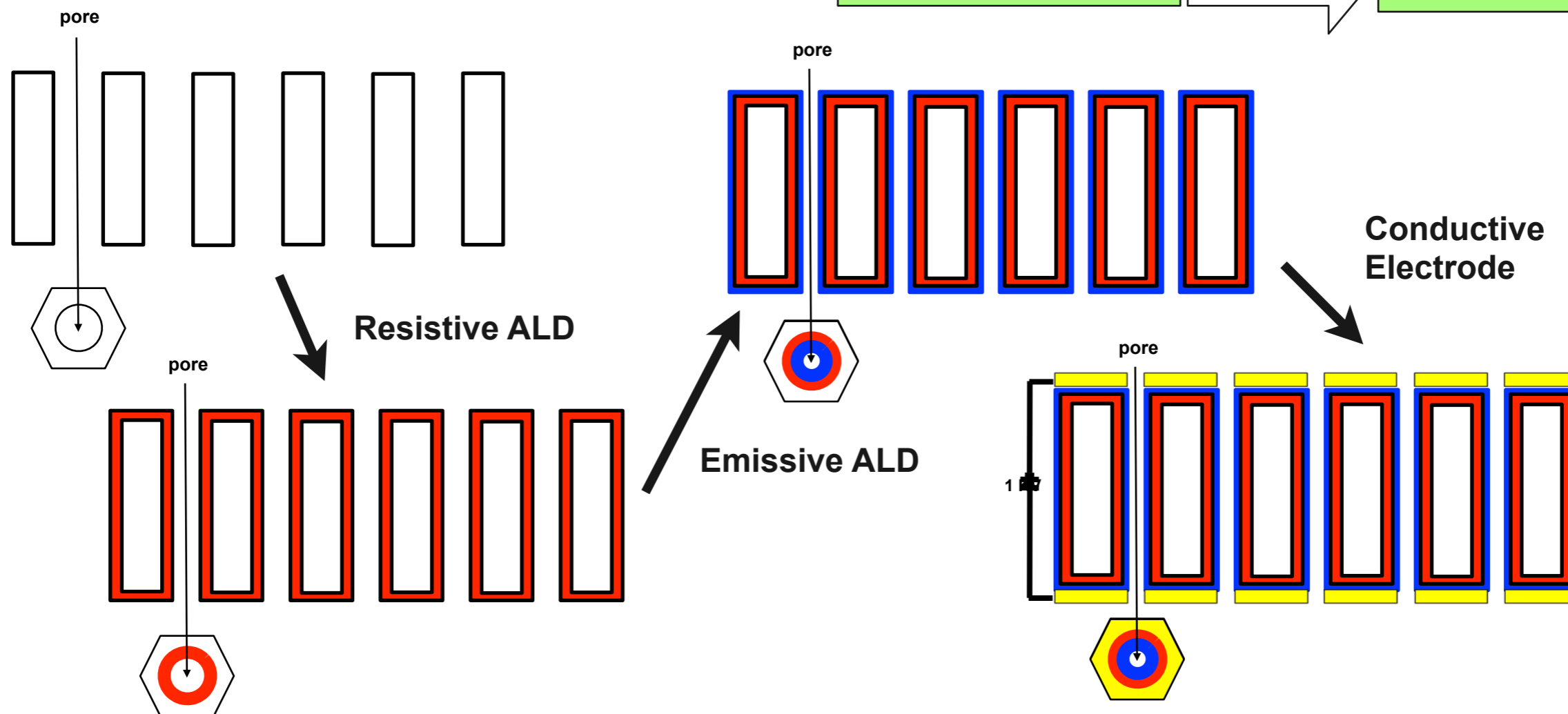
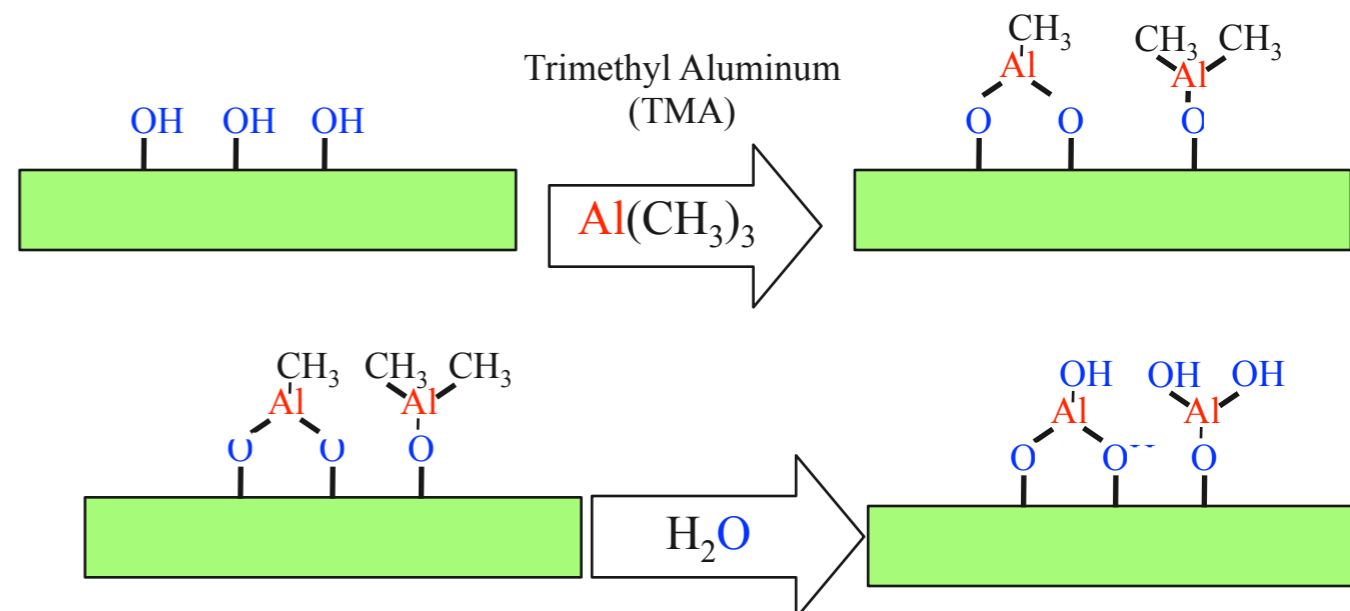


Before sealing in tube, plate must be subjected to prolonged exposure to electrons at low voltage to outgas H_2 and other material

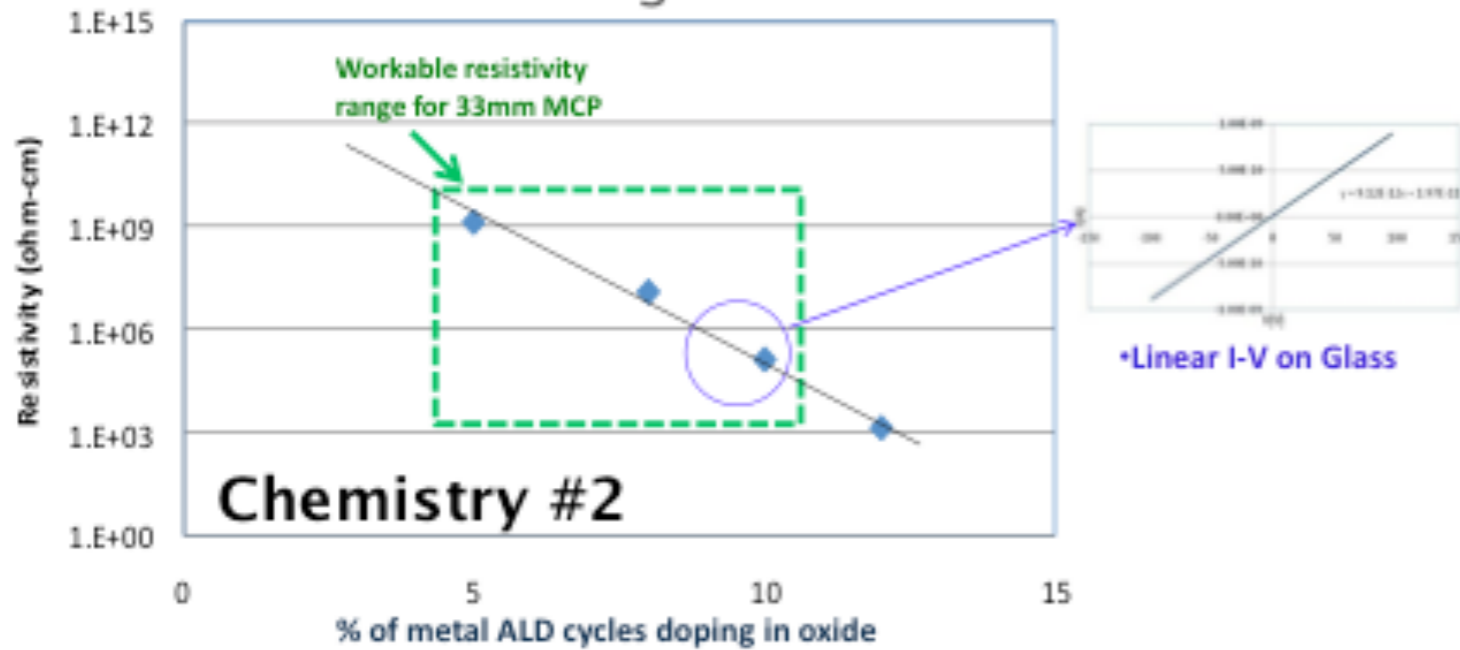
Pore Activation via Atomic Layer Deposition (ALD)

Example:

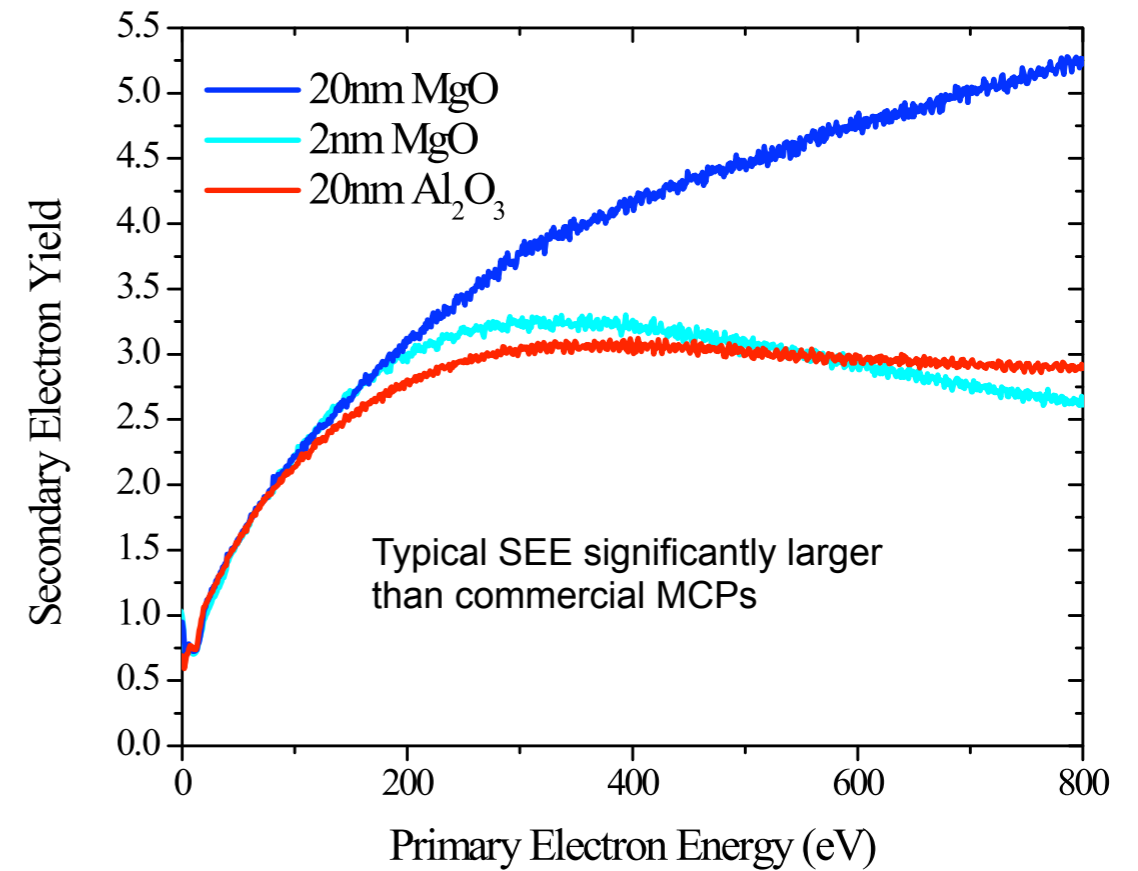
- OH on surface provide reaction sites
 - Trimethyl aluminum reacts liberating methane, forms Al_2O_3 layer. Leaves methyl group inhibiting further reaction on surface
 - Exposure to H_2O removes methyl group. Leaves OH sites for next reaction
- Leaves OH sites for next reaction



Materials Characterization

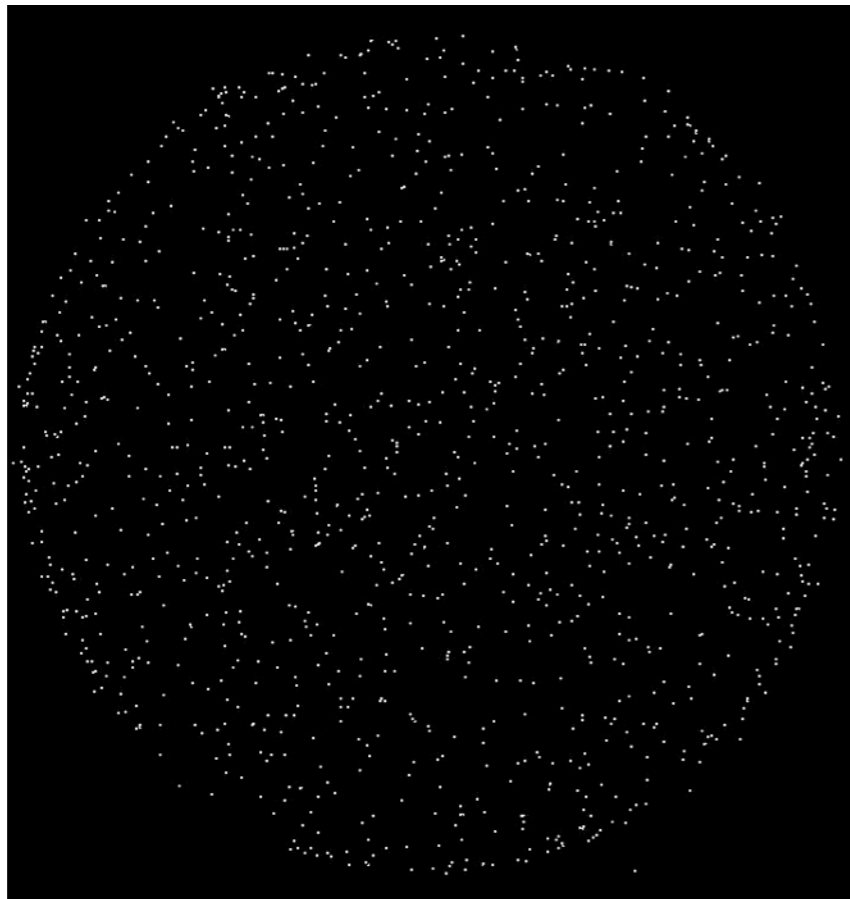


Secondary Emissive Materials characterized with Low Energy Electron Diffraction (LEED)

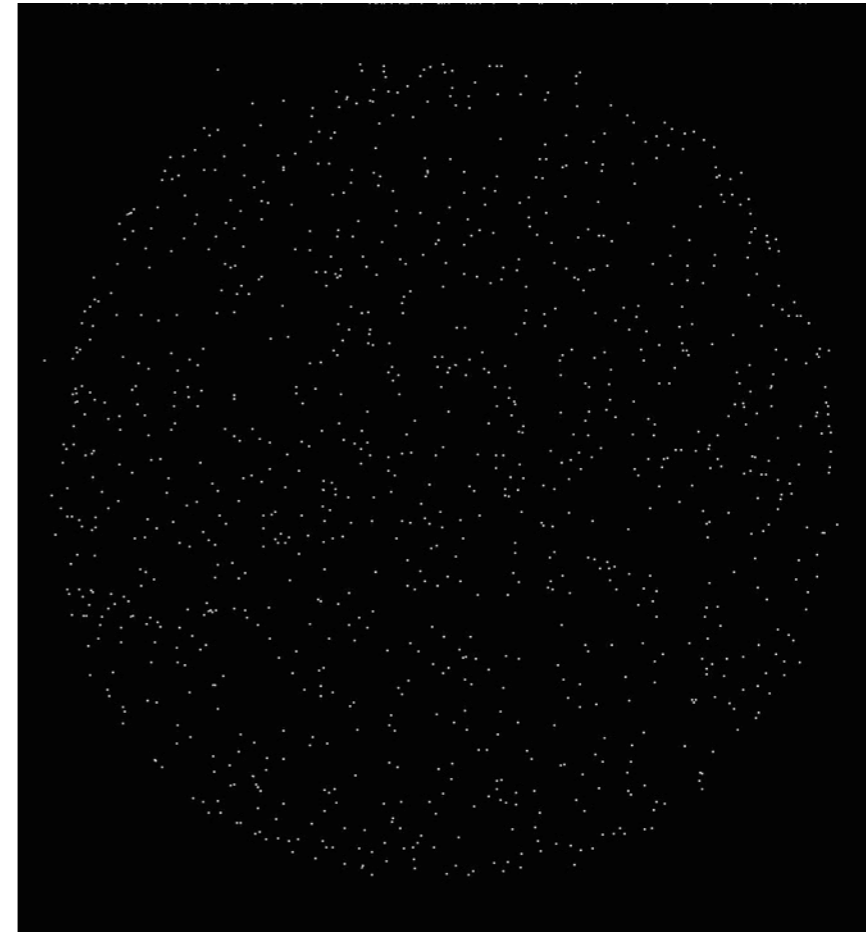


Noise Characterization

MgO SEE Layer

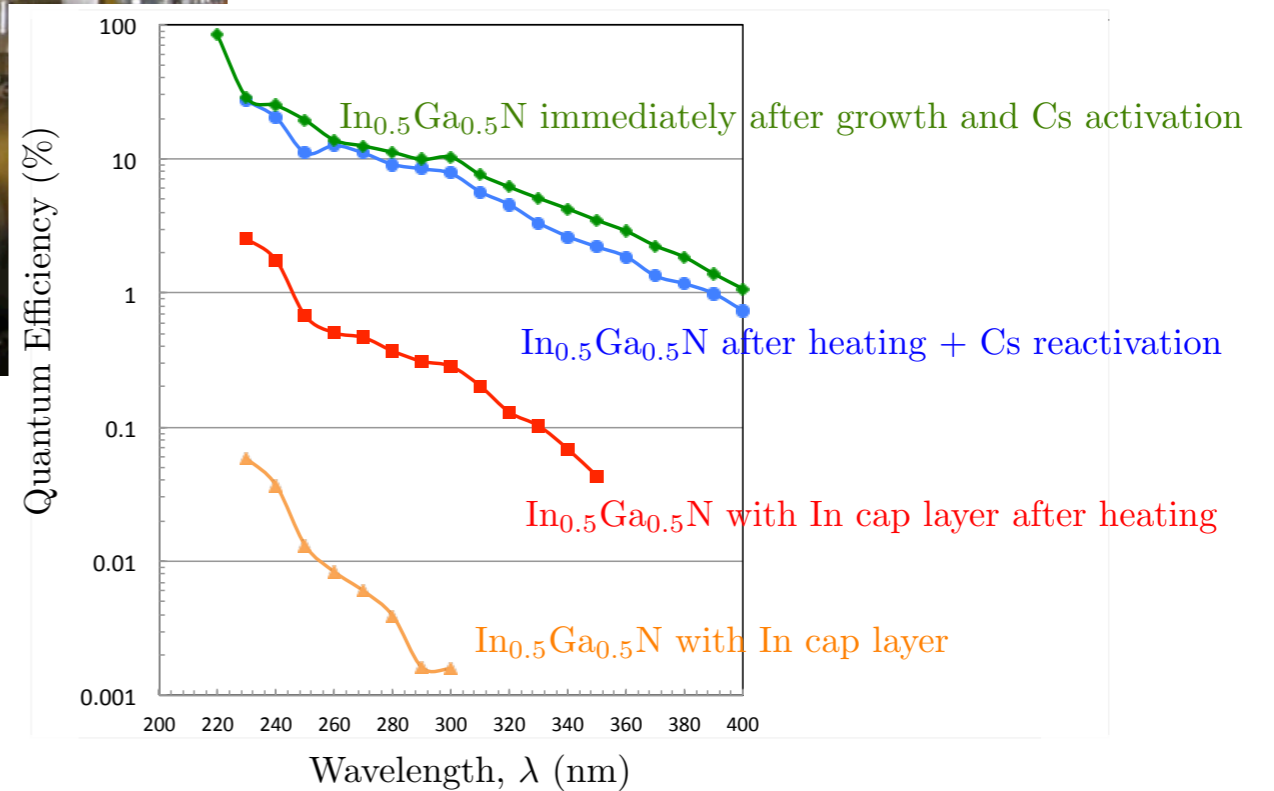
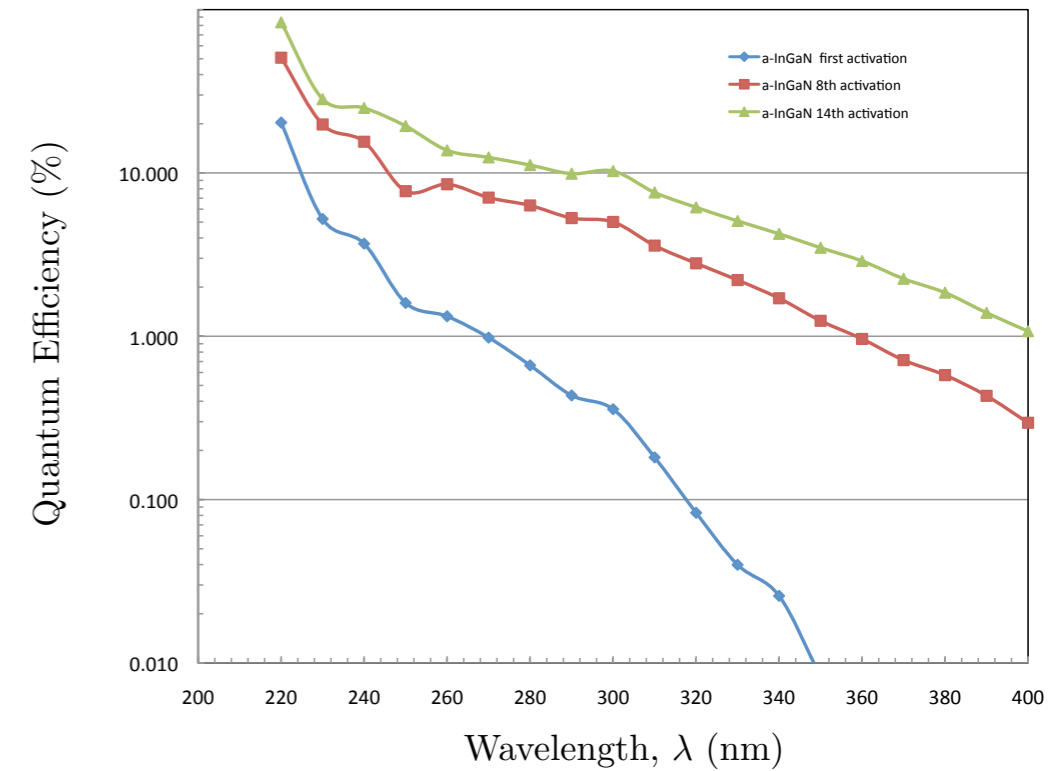
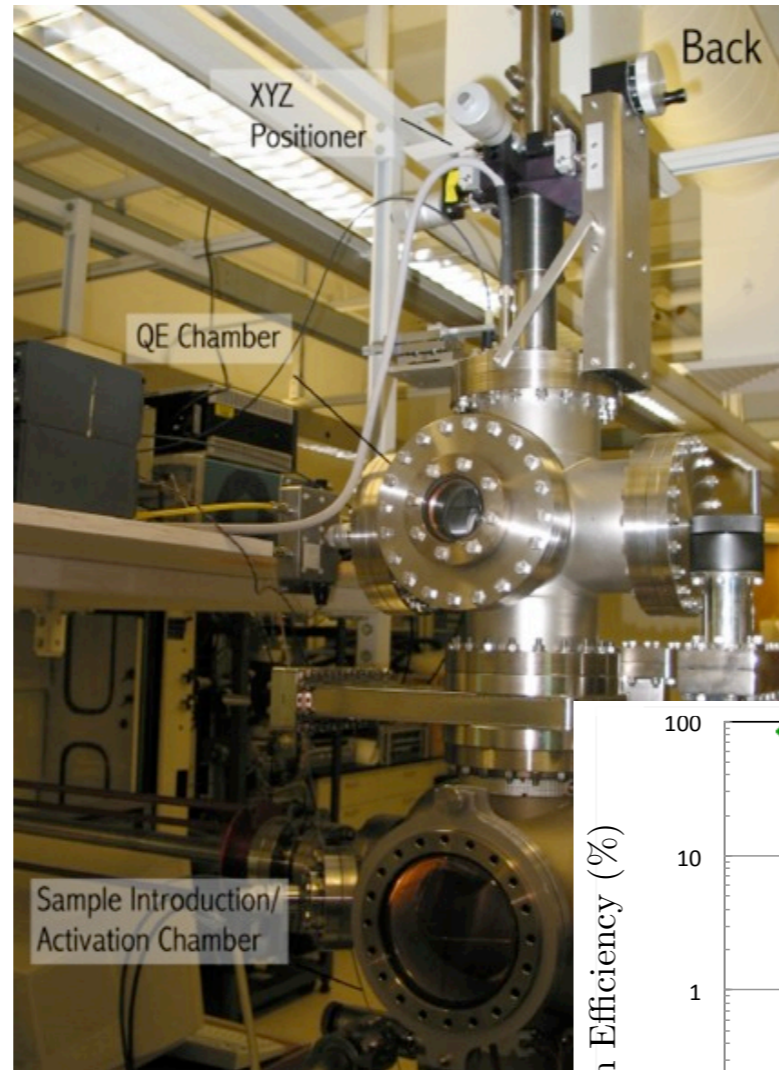
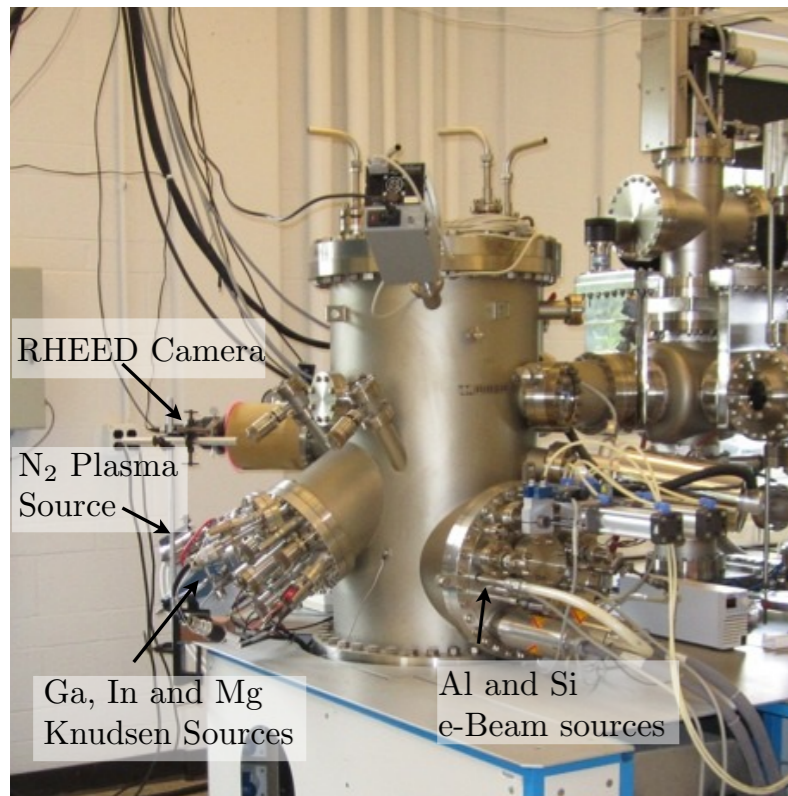


3000 sec background, $0.0845 \text{ events cm}^{-2} \text{ sec}^{-1}$ at 7×10^6 gain, 1025v bias on each MCP. Get same behavior for most of the current $20\mu\text{m}$ MCPs



Post-bake –2000 sec
 $\sim 0.1 \text{ events cm}^{-2} \text{ sec}^{-1}$

InGaN Photocathode Development – Washington University

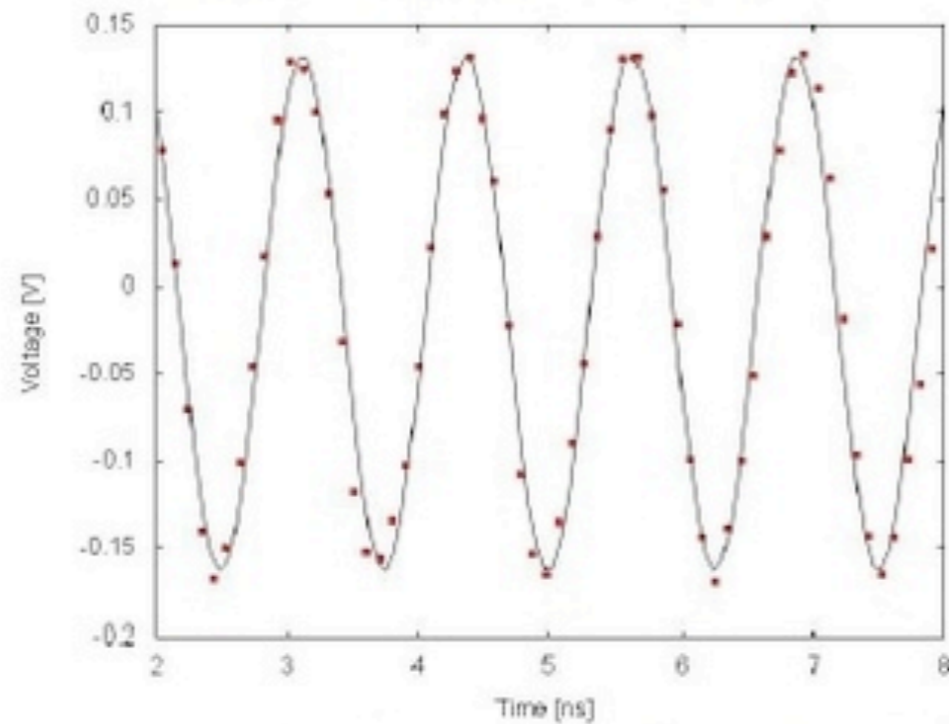


PSEC4 Performance

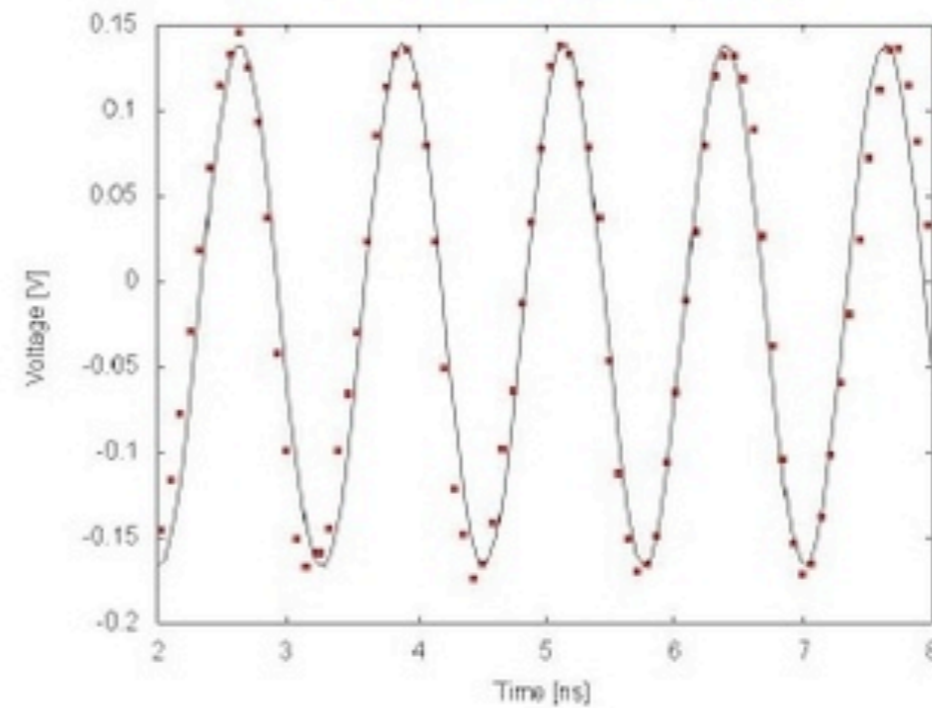
Digitized Waveforms

Input: 800MHz, 300 mV_{pp} sine

Sampling rate : 10 GSa/s



Sampling rate : 13.3 GSa/s



- Only simple pedestal correction to data
- As the sampling rate-to-input frequency ratio decreases, the need for time-base calibration becomes more apparent (depending on necessary timing resolution)

Existing 4" Vacuum Transfer System at Argonne – System for Early Vetting of STF Process



Two chamber CsTe Photocathode Transfer System



Indium Top Seal Vacuum Test Chamber

Possible early STF demonstrator:

- Chambers can be coupled via existing 6" flanges to give PC process chamber and sealing chamber.
- Left system is operating now at 5×10^{-10} torr, right system is 10^{-8} torr